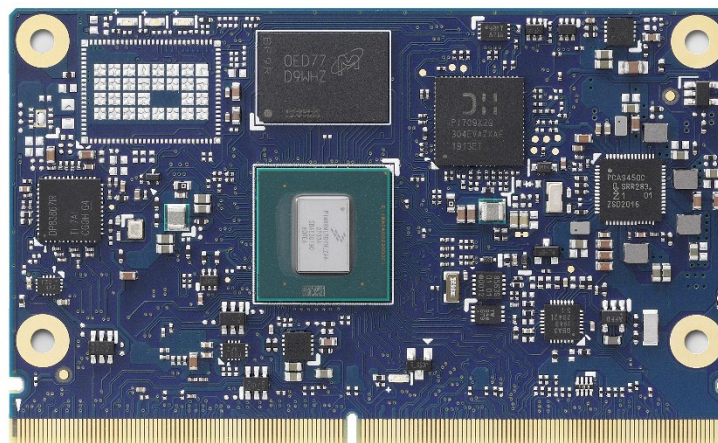


LEC-IMX8M Plus

User's Guide



Revision: Rev. 1.1
Date: 2023-06-14
Part Number: 50M-72512-1010



Revision History

Revision	Description	Date	Author
1.0	Initial release	2023-04-20	CC
1.1	I2C pin info corrected	2023-06-14	CC

Preface

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Safety Instructions

For user safety, please read and follow all Instructions, **WARNINGS**, **CAUTIONS**, and **NOTES** marked in this manual and on the associated equipment before handling/operating the equipment.

Read these safety instructions carefully.

- Keep this manual for future reference.
- Read the specifications section of this manual for detailed information on the operating environment of this equipment.
- Turn off power and unplug any power cords/cables when installing/mounting or un-installing/removing equipment.
- To avoid electrical shock and/or damage to equipment:
 - Keep equipment away from water or liquid sources;
 - Keep equipment away from high heat or high humidity;
 - Keep equipment properly ventilated (do not block or cover ventilation openings);
 - Make sure to use recommended voltage and power source settings;
 - Always install and operate equipment near an easily accessible electrical socket outlet;
 - Secure the power cord (do not place any object on/over the power cord);
 - Only install/attach and operate equipment on stable surfaces and/or recommended mountings;
 - If the equipment will not be used for long periods of time, turn off the power source and unplug the equipment.

Conventions

The following conventions may be used throughout this manual, denoting special levels of information



Note: This information adds clarity or specifics to text and illustrations.



Caution: This information indicates the possibility of minor physical injury, component damage, data loss, and/or program corruption.



Warning: This information warns of possible serious physical injury, component damage, data loss, and/or program corruption.

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1. Introduction

1.1 LEC-iMX8M Plus

ADLINK LEC-iMX8MP is a SMARC module based on NXP iMX8M Plus (4-core Arm Cortex-A53) processor with an optional Neural Processing Unit (NPU) operating at up to 2.3 TOPS. It is the first SMARC Revision 2.1 module focusing on machine learning and vision, advanced multimedia, and industrial IoT, and with high reliability. The module also supports dual-image signal processors and 2x camera inputs for an effective vision system, and is especially suited for applications such as smart home, smart city, and industrial 4.0.

1.2 The SMARC Form Factor

The SMARC ("Smart Mobility ARChitecture") is a versatile small form factor Computer on Module definition targeting applications that require low power and high performance at low costs. Typically under 6W, the modules often utilize ARM and other alternative low-power option CPUs, and are used in many familiar handheld devices, such as tablet computers and smart phones.

Two module sizes are defined in SMARC: 82 mm x 50 mm and 82 mm x 80 mm.

The module PCBs have 314 edge fingers that mate with a low-profile 314 pin 0.5 mm pitch right angle connector (the connector is sometimes identified as a 321 pin connector, with 7 pins used by the key).

SMARC modules are used as building blocks for portable and stationary embedded systems. The core CPU and support circuits, including DRAM, boot flash, power sequencing, CPU power supplies, GBE and a single channel LVDS display transmitter are concentrated on the module. Modules are used with application-specific carrier boards that implement other features such as audio codecs, touch controllers, wireless devices, etc.

The modular approach allows scalability, faster time to market and upgradability while still maintaining low costs, low power, and small physical size.



SMARC module and carrier specifications are available online at: <https://www.sget.org/standards/smarc.html>

2. Specifications

2.1 Core System

SoC

NXP iMX8M Plus series, available with standard (0°C to 70°C) or extreme rugged (-40°C to 85°C) operating temperature

- i.MX8M-plus Quad NPU 4x Arm Cortex-A53 at 1.6 to 1.8GHz, 1x Arm Cortex-M7, NPU, GPU, VPU Decode/Encode
- i.MX8M-plus Quad 4x Arm Cortex-A53 at 1.6 to 1.8GHz, 1x Arm Cortex-M7, GPU, VPU Decode/Encode
- i.MX8M-plus QuadLite 4x Arm Cortex-A53 at 1.6 to 1.8GHz, 1x Arm Cortex-M7

L2 Cache

32KB I-cache, 32KB D-cache (A53), 512KB L2 Cache (ECC)

Memory

2/4/8GB LPDDR4 memory down (inline ECC)

Security

- CryptoAuthentication™ Device, Microchip ATECC608A (optional)
- Cryptographic co-processor with secure hardware-based key storage
- Protected storage for up to 16 Keys, certificates or data
- ECDH: FIPS SP800-56A Elliptic Curve Diffie-Hellman
- NIST standard P256 elliptic curve support
- SHA-256 & HMAC hash including off-chip context save/restore
- AES-128: encrypt/decrypt, galois field multiply for GCM
- TPM 2.0 Device, ST Microelectronics ST33HTPH2X32AHD5 (optional)
- Compliant with Trusted Computing Group (TCG) Trusted Platform Module (TPM) Library specifications 2.0, Level 0, Revision 138 and TCG PC Client Specific TPM Platform Specifications 1.03
- Fault-tolerant firmware loader that keeps the TPM fully functional when the loading process is interrupted (self-recovery)
- SP800-193 compliant for protection, detection, and recovery requirements

2.2 Video

LEC-iMX8M Plus supports 1K-capable HDMI 2.0a, a single/dual channel 24-bit LVDS, and a 4-lane DSI.

GPU Core

Vivante GC7000UL 3D GC520L 2D

GPU/VPU Features

GPU: 2 shaders, OpenGL ES 1.1, 2.9, 3.0, OpenCL 1.2, OpenGL 3.0, and Vulkan, up to 1080p FHD resolutions

VPU : 1080p60 HEVC/H.265, H.264, VP9 Decoder | 1080p60 AVC/H.264/ HEVC/H.265 encoder

NPU (optional)

2.3 TOP/s Neural Network performance

Keyword detect, noise reduction, beamforming, Speech recognition (i.e. Deep Speech 2), Image recognition (i.e. ResNet-50)

HDMI

HDMI 2.0a supporting resolutions up to 1920×1080 at 60Hz

LVDS

LVDS single/dual channel 24-bit at max. 1920×080 at 60Hz

MIPI DSI

DSI 4 lanes at max. 1080p@60fps display output (multiplexed with LVDS signal)

Camera Support

Compatible with MIPI Alliance Interface specification v2.1

2x MIPI-CSI2 camera inputs, 1x 4-lane and 1x 2-lane

2.3 Audio

Supports I2S audio codec interface, audio ADC and DAC (located on carrier)

2.4 Dual Ethernet

Primary LAN

Gigabit Ethernet controller with support for TSN in addition to Energy Efficient Ethernet (EEE), Ethernet AVB, and IEEE 1588

Supports 10/100/1000Mbps data transfer rates, both full-duplex and half-duplex

Secondary LAN

Gigabit Ethernet controller with support for Energy Efficient Ethernet (EEE), Ethernet AVB, and IEEE 1588

Supports 10/100/1000Mbps data transfer rates, both full-duplex and half-duplex

2.5 1216 M.2 LGA Wi-Fi (optional)

Optional Wi-Fi LGA module support

In case of non-populated part, the footprint is still there and visible

Only Azurewave AW-CM276NF has been validated during DVT but other M.2 LGA modules could also be compatible if they use the same standard interfaces, as listed below

- SDIO0 (main Wi-Fi interface)
- UART1 (main Bluetooth interface)
- PCM (Bluetooth audio transfer interface)



- **Note** : AW-CM276F has been pre-certified by Azurewave for several countries and regions, ADLINK can assist in final device certification if applicable. FCC ID: UAY-W8997-M1216

2.6 Extension Busses

PCIe

2x PCI Express Gen2 x1 interfaces

USB

CT temp 2x USB 3.0/2.0, 3x USB 2.0, 1x USB2.0 OTG

ER temp 1x USB 3.0, 1x USB2.0 OTG

UART

4x UART interface SER0, SER2 (Tx/Rx/CTS/RTS) and SER1, SER3(optional) (Tx/Rx)

7- or 8-bit data words, 1 or 2 stop bits, programmable parity (even, odd, or none)

Programmable baud rates up to 4 Mbps.

CAN bus

2x CAN2.0B only or mixed CAN2.0B and CAN FB mode, data bit rate up to 8 Mbps

SPI

2x SPI

I2S

I2S interface (codec on carrier)

I2C

5x I2C interfaces

Supports 7-bit and 10-bit address mode

Software programmable clock frequency:

- 100 kbit/s in Standard-mode,
- 400 kbit/s in Fast-mode
- 1 Mbit/s in Fast-mode Plus

GPIO

14x GPIO with interrupt

2.7 System Storage

SDIO

1x SDIO (4-bit) compatible up to version 3.0.

eMMC

Soldered on module 16, 32 or 64GB (build option) either standard or -40 to 85°C temperature range

Compatible with eMMC specifications 4.41, 4.51, and 5.0

2.8 SEMA® Board Management Controller

Voltage/current monitoring, boot configuration, logistics and forensic information, flat panel control, watchdog timer

2.9 Debug Header

30-pin multipurpose flat cable connector for use with optional DB-30 debug module

Provides JTAG, BMC access; UART, power test points; diagnostic LEDs, Power, Reset, Boot configuration

2.10 Boot Modes

eMMC and SD card boot modes are supported

2.11 Power

Supply Voltage

4.75V – 5.25V

2.12 Mechanical and Environmental

Form Factor

SGET SMARC Specifications v2.1

Dimension

SMARC small size module, 82mm x 50mm

Operating Temperature

Standard: 0°C to 60°C

Rugged: -40°C to 85°C (optional)

Humidity

5-90% RH operating, non-condensing

5-95% RH storage (and operating with conformal coating)

Shock and Vibration

IEC 60068-2-64 and IEC-60068-2-27, MIL-STD-202 F, Method 213B, Table 213-I,

Condition A and Method 214A, Table 214-I, Condition D

3. Block Diagram

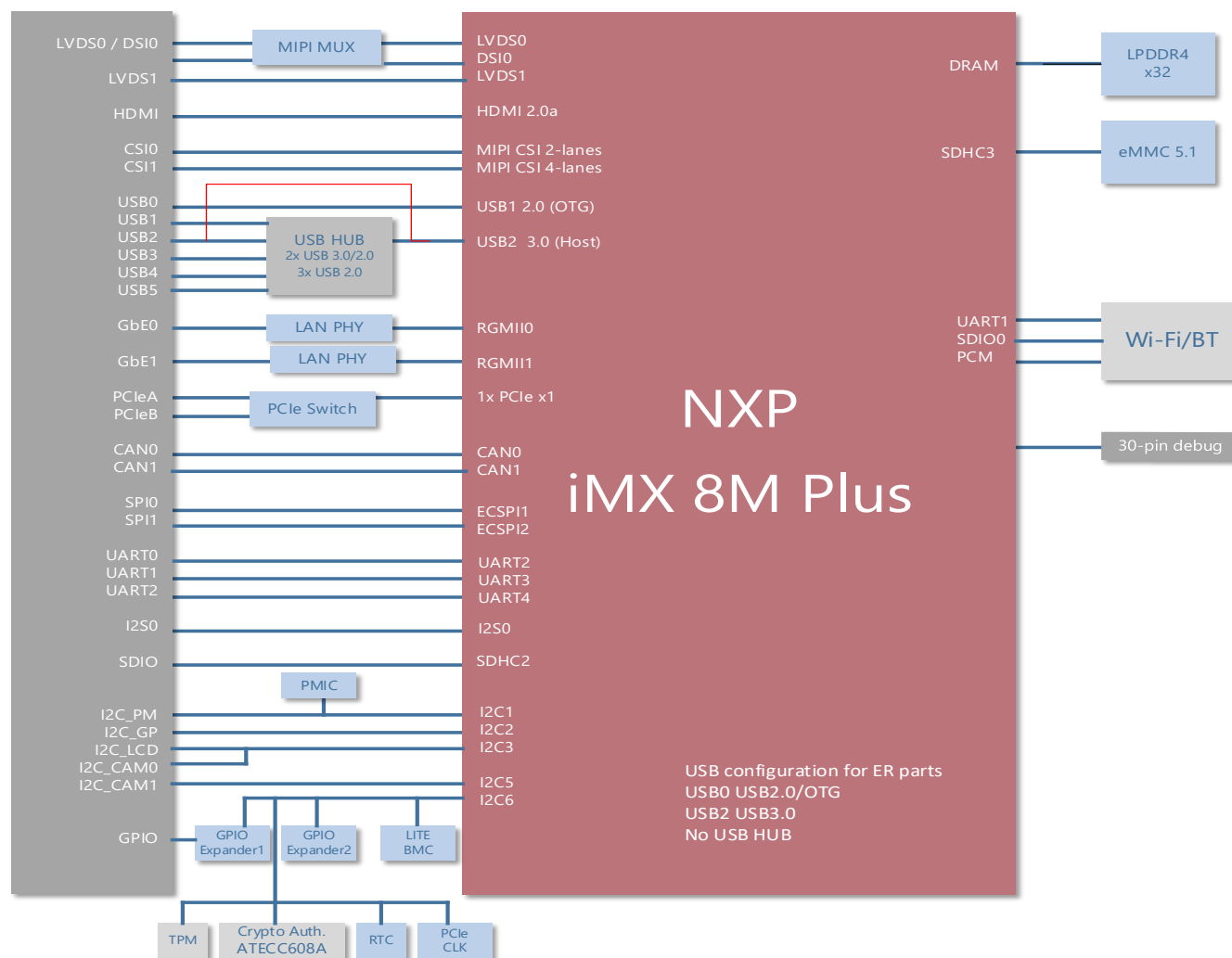


Figure 1 – Module function diagram

4. Pinout and Signal Descriptions

4.1 Pin Summary

The below table is a comprehensible list of all signal pins on the MXM 3 connector in the standard specification SMARC 2.1.

Those signals not supported on LEC-iMX8M plus are strikethrough ~~STRIKETHROUGH~~

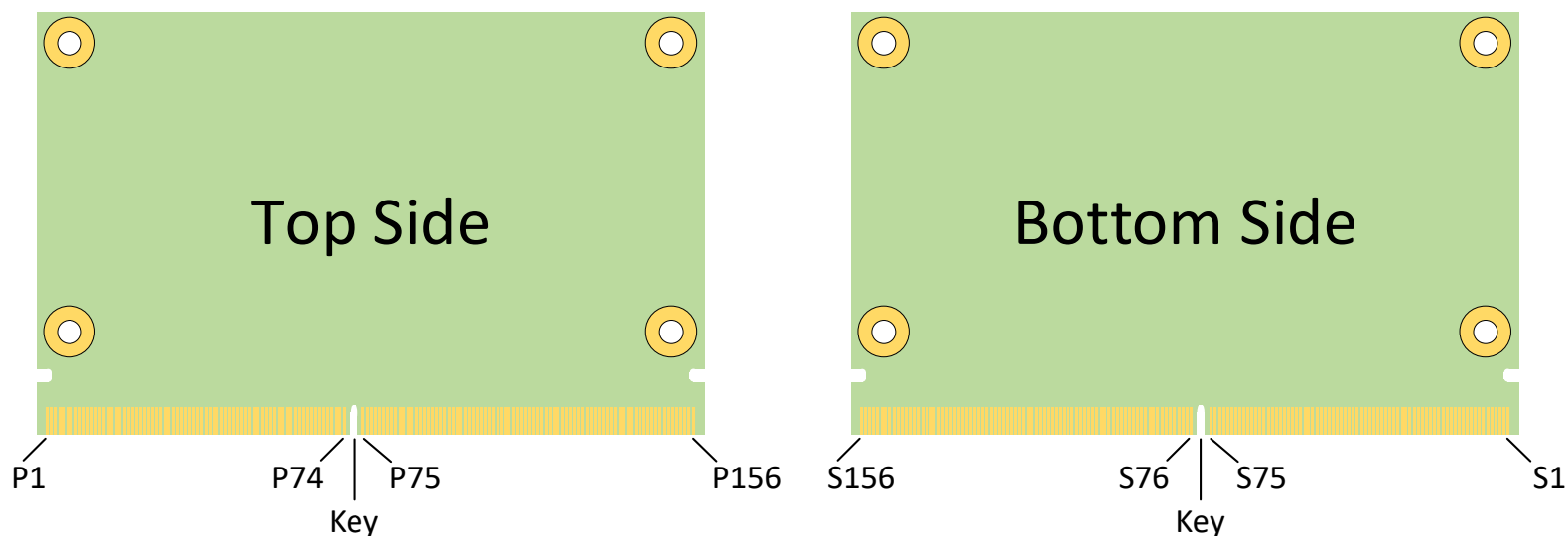


Figure 2 – Module top/bottom side pin numbering

P-Pin	Primary (Top) Side
P1	SMB_ALERT_1V8#
P2	GND
P3	CSI1_CK+
P4	CSI1_CK-
P5	GBE1_SDP
P6	GBE0_SDP
P7	CSI1_RX0+
P8	CSI1_RX0-
P9	GND
P10	CSI1_RX1+
P11	CSI1_RX1-
P12	GND
P13	CSI1_RX2+
P14	CSI1_RX2-
P15	GND
P16	CSI1_RX3+
P17	CSI1_RX3-
P18	GND
P19	GBE0_MDI3-
P20	GBE0_MDI3+
P21	GBE0_LINK100#
P22	GBE0_LINK1000#
P23	GBE0_MDI2-
P24	GBE0_MDI2+
P25	GBE0_LINK_ACT#
P26	GBE0_MDI1-
P27	GBE0_MDI1+
P28	GBE0_CTREF
P29	GBE0_MDI0-
P30	GBE0_MDI0+
P31	SPI0_CS1
P32	GND
P33	SDIO_WP
P34	SDIO_CMD

S-Pin	Secondary (Bottom) Side
S1	CSI1_TX+ / I2C_CAM1_CK
S2	CSI1_TX- / I2C_CAM1_DAT
S3	GND
S4	RSVD
S5	CSI0_TX- / I2C_CAM0_CK
S6	CAM_MCK
S7	CSI0_TX+ / I2C_CAM0_DAT
S8	CSI0_CK+
S9	CSI0_CK-
S10	GND
S11	CSI0_RX0+
S12	CSI0_RX0-
S13	GND
S14	CSI0_RX1+
S15	CSI0_RX1-
S16	GND
S17	GBE1_MDI0+
S18	GBE1_MDI0-
S19	GBE1_LINK100#
S20	GBE1_MDI1+
S21	GBE1_MDI1-
S22	GBE1_LINK1000#
S23	GBE1_MDI2+
S24	GBE1_MDI2-
S25	GND
S26	GBE1_MDI3+
S27	GBE1_MDI3-
S28	GBE1_CTREF
S29	PCIE_D_TX+ / SERDES_1_TX+
S30	PCIE_D_TX- / SERDES_1_TX-
S31	GBE1_LINK_ACT#
S32	PCIE_D_RX+ / SERDES_1_RX+
S33	PCIE_D_RX- / SERDES_1_RX-
S34	GND
S35	USB4+

P-Pin	Primary (Top) Side
P35	SDIO_CD#
P36	SDIO_CK
P37	SDIO_PWR_EN
P38	GND
P39	SDIO_D0
P40	SDIO_D1
P41	SDIO_D2
P42	SDIO_D3
P43	SPI0_CS0#
P44	SPI0_CK
P45	SPI0_DIN
P46	SPI0_DO
P47	GND
P48	SATA_TX+
P49	SATA_TX-
P50	GND
P51	SATA_RX+
P52	SATA_RX-
P53	GND
P54	ESPI_CS0# / SPI1_CS0#
P55	ESPI_CS1# / SPI1_CS1#
P56	ESPI_CK / SPI1_CK
P57	ESPI_IO_1 / SPI1_DIN
P58	ESPI_IO_0 / SPI1_DO
P59	GND
P60	USB0+
P61	USB0-
P62	USB0_EN_OC#
P63	USB0_VBUS_DET
P64	USB0_OTG_ID
P65	USB1+
P66	USB1-
P67	USB1_EN_OC#
P68	GND
P69	USB2+

S-Pin	Secondary (Bottom) Side
S36	USB4-
S37	USB3_VBUS_DET
S38	AUDIO_MCK
S39	I2S0_LRCK
S40	I2S0_SDOUT
S41	I2S0_SDIN
S42	I2S0_CK
S43	ESPI_ALERT0#
S44	ESPI_ALERT1#
S45	MDIO_CLK
S46	MDIO_DAT
S47	GND
S48	I2C_GP_CK
S49	I2C_GP_DAT
S50	HDA_SYNC / I2S2_LRCK
S51	HDA_SDO / I2S2_SDOUT
S52	HDA_SDI / I2S2_SDIN
S53	HDA_CK / I2S2_CK
S54	SATA_ACT#
S55	USB5_EN_OC
S56	ESPI_IO_2
S57	ESPI_IO_3
S58	ESPI_RESET#
S59	USB5+
S60	USB5-
S61	GND
S62	USB3_SSTX+
S63	USB3_SSTX-
S64	GND
S65	USB3_SSRX+
S66	USB3_SSRX-
S67	GND
S68	USB3+
S69	USB3-
S70	GND

P-Pin	Primary (Top) Side
P70	USB2-
P71	USB2_EN_OC#
P72	RSVD
P73	RSVD
P74	USB3_EN_OC#
	Key
P75	PCIE_A_RST#
P76	USB4_EN_OC#
P77	PCIE_B_CKREQ#
P78	PCIE_A_CKREQ#
P79	GND
P80	PCIE_C_REFCK+
P81	PCIE_C_REFCK-
P82	GND
P83	PCIE_A_REFCK+
P84	PCIE_A_REFCK-
P85	GND
P86	PCIE_A_RX+
P87	PCIE_A_RX-
P88	GND
P89	PCIE_A_TX+
P90	PCIE_A_TX-
P91	GND
P92	HDMI_D2+ / DP1_LANE0+
P93	HDMI_D2- / DP1_LANE0-
P94	GND
P95	HDMI_D1+ / DP1_LANE1+
P96	HDMI_D1- / DP1_LANE1-
P97	GND
P98	HDMI_D0+ / DP1_LANE2+
P99	HDMI_D0- / DP1_LANE2-
P100	GND
P101	HDMI_CK+ / DP1_LANE3+

S-Pin	Secondary (Bottom) Side
S71	USB2_SSTX+
S72	USB2_SSTX-
S73	GND
S74	USB2_SSRX+
S75	USB2_SSRX-
	Key
S76	PCIE_B_RST#
S77	PCIE_C_RST#
S78	PCIE_C_RX+ / SERDES_2_RX+
S79	PCIE_C_RX- / SERDES_2_RX-
S80	GND
S81	PCIE_C_TX+ / SERDES_2_TX+
S82	PCIE_C_TX- / SERDES_2_TX-
S83	GND
S84	PCIE_B_REFCK+
S85	PCIE_B_REFCK-
S86	GND
S87	PCIE_B_RX+
S88	PCIE_B_RX-
S89	GND
S90	PCIE_B_TX+
S91	PCIE_B_TX-
S92	GND
S93	DP0_LANE0+
S94	DP0_LANE0-
S95	DP0_AUX_SEL
S96	DP0_LANE1+
S97	DP0_LANE1-
S98	DP0_HPD
S99	DP0_LANE2+
S100	DP0_LANE2-
S101	GND
S102	DP0_LANE3+

P-Pin	Primary (Top) Side
P102	HDMI_CK- / DP1_LANE3-
P103	GND
P104	HDMI_HPD / DP1_HPD
P105	HDMI_CTRL_CK / DP1_AUX+
P106	HDMI_CTRL_DAT / DP1_AUX-
P107	DP1_AUX_SEL
P108	GPIO0 / CAM0_PWR#
P109	GPIO1 / CAM1_PWR#
P110	GPIO2 / CAM0_RST#
P111	GPIO3 / CAM1_RST#
P112	GPIO4 / HDA_RST#
P113	GPIO5 / PWM_OUT
P114	GPIO6 / TACHIN
P115	GPIO7
P116	GPIO8
P117	GPIO9
P118	GPIO10
P119	GPIO11
P120	GND
P121	I2C_PM_CK
P122	I2C_PM_DAT
P123	BOOT_SEL0#
P124	BOOT_SEL1#
P125	BOOT_SEL2#
P126	RESET_OUT#
P127	RESET_IN#
P128	POWER_BTN#
P129	SER0_TX
P130	SER0_RX
P131	SER0_RTS#
P132	SER0_CTS#
P133	GND
P134	SER1_TX
P135	SER1_RX
P136	SER2_TX

S-Pin	Secondary (Bottom) Side
S103	DP0_LANE3-
S104	USB3_OTG_ID
S105	DP0_AUX+
S106	DP0_AUX-
S107	LCD1_BKLT_EN
S108	LVDS1_CK+/eDP1_AUX+/DSI1_CLK+
S109	LVDS1_CK-/eDP1_AUX-/DSI1_CLK-
S110	GND
S111	LVDS1_0+ / eDP1_TX0+ / DSI1_D0+
S112	LVDS1_0- / eDP1_TX0- / DSI1_D0-
S113	eDP1_HPD / DSI1_TE
S114	LVDS1_1+ / eDP1_TX1+ / DSI1_D1+
S115	LVDS1_1- / eDP1_TX1- / DSI1_D1-
S116	LCD1_VDD_EN
S117	LVDS1_2+ / eDP1_TX2+ / DSI1_D2+
S118	LVDS1_2- / eDP1_TX2- / DSI1_D2-
S119	GND
S120	LVDS1_3+ / eDP1_TX3+ / DSI1_D3+
S121	LVDS1_3- / eDP1_TX3- / DSI1_D3-
S122	LCD1_BKLT_PWM
S123	GPIO13
S124	GND
S125	LVDS0_0+ / eDP0_TX0+ / DSI0_D0+
S126	LVDS0_0- / eDP0_TX0- / DSI0_D0-
S127	LCD0_BKLT_EN
S128	LVDS0_1+ / eDP0_TX1+ / DSI0_D1+
S129	LVDS0_1- / eDP0_TX1- / DSI0_D1-
S130	GND
S131	LVDS0_2+ / eDP0_TX2+ / DSI0_D2+
S132	LVDS0_2- / eDP0_TX2- / DSI0_D2-
S133	LCD0_VDD_EN
S134	LVDS0_CK+/eDP0_AUX/ DSI0_CLK+
S135	LVDS0_CK-/eDP0_AUX-/ DSI0_CLK-
S136	GND
S137	LVDS0_3+ / eDP0_TX3+ / DSI0_D3+

P-Pin	Primary (Top) Side
P137	SER2_RX
P138	SER2_RTS#
P139	SER2_CTS#
P140	SER3_TX
P141	SER3_RX
P142	GND
P143	CAN0_TX
P144	CAN0_RX
P145	CAN1_TX
P146	CAN1_RX
P147	VDD_IN

S-Pin	Secondary (Bottom) Side
S138	LVDS0_3- / eDP0_TX3- / DSI0_D3-
S139	I2C_LCD_CK
S140	I2C_LCD_DAT
S141	LCD0_BKLT_PWM
S142	GPIO12
S143	GND
S144	eDP0_HPD / DSI0_TE
S145	WDT_TIME_OUT#
S146	PCIE_WAKE#
S147	VDD_RTC
S148	LID#

P-Pin	Primary (Top) Side
P148	VDD_IN
P149	VDD_IN
P150	VDD_IN
P151	VDD_IN
P152	VDD_IN
P153	VDD_IN
P154	VDD_IN
P155	VDD_IN
P156	VDD_IN

S-Pin	Secondary (Bottom) Side
S149	SLEEP#
S150	VIN_PWR_BAD#
S151	CHARGING#
S152	CHARGER_PRSENT#
S153	CARRIER_STBY#
S154	CARRIER_PWR_ON
S155	FORCE_RECOV#
S156	BATLOW#
S157	TEST#
S158	GND



Note: DSI0 is pin-shared with LVDS0

4.2 Signal Terminology Descriptions

Meaning of the terms used for signal description tables. Signals described in the specification but not supported on the LEC-iMX8M Plus are marked with strikethrough ~~STRIKETHROUGH~~

Term	Description
I	Input to the module
O	Output from the module
O OD	Open drain output from the module
I OD	Open drain input to the module, with mandatory PU (pull up) on module
OD	Open drain
I/O	Bi-directional Input/Output
PU	PU (pull-up) resistor on module
PD	PD (pull-down) resistor on module
VDD_IN	Main power source from carrier to module
CMOS	Logic input or output
GBE MDI	Differential analog signaling for Gigabit Media Dependent Interface
LVDS DP	Low Voltage Differential Signal for DisplayPort interface
LVDS D-PHY	Low Voltage Differential Signal for MIPI CSI-2 cameras and DSI displays
LVDS M-PHY	Low Voltage Differential Signal for MIPI CSI-3 cameras
LVDS LCD	Low Voltage Differential Signal for LCD displays
LVDS PCIE	Low Voltage Differential Signal for PCIe
LVDS SATA	Low Voltage Differential Signal for SATA
TMDS HDMI	Transition Minimized Differential Signal for HDMI displays
USB	DC coupled differential signaling for traditional (non-Superspeed) USB signals
USB SS	Differential signal for SuperSpeed USB signals
USB VBUS 5V	5V tolerant input for USB VBUS detection
3.3V	3.3V Power Domain: Active while CARRIER_PWRON is high and CARRIER_SBY# is NOT active (i.e. both signals are high)
1.8V	1.8V Power Domain: Active while CARRIER_PWRON is high and CARRIER_SBY# is NOT active (i.e. both signals are high)
3.3Vsb	3.3V Power Domain: Active while CARRIER_PWRON is high (regardless of CARRIER_SBY#)
1.8Vsb	1.8V Power Domain: Active while CARRIER_PWRON is high (regardless of CARRIER_SBY#)

4.3 Signal Description by Function

4.3.1 The First Display Interface

The first display interface is a group of 30-pins that is split into channel 0 and channel 1. The SMARC specification allows support for dual channel LVDS ports, 2 separate single channel LVDS ports, 2 MIPI DSI ports of 4 lanes each or 2 eDP ports 4 lanes each. A mix of different display types such as DSI and eDP is also permitted. Below tables show which display ports are supported on this particular module.

Pin #	LVDS Name	MIPI DSI Name	eDP Name
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S125	LVDS0_0+	DSI0_D0+	eDP0_TX0+
S126	LVDS0_0-	DSI0_D0-	eDP0_TX0-
S128	LVDS0_1+	DSI0_D1+	eDP0_TX1+
S129	LVDS0_1-	DSI0_D1-	eDP0_TX1-
S131	LVDS0_2+	DSI0_D2+	eDP0_TX2+
S132	LVDS0_2-	DSI0_D2-	eDP0_TX2-
S137	LVDS0_3+	DSI0_D3+	eDP0_TX3+
S138	LVDS0_3-	DSI0_D3-	eDP0_TX3-
S134	LVDS0_CLK+	DSI0_CLK+	eDP0_AUX+
S135	LVDS0_CLK-	DSI0_CLK-	eDP0_AUX-
S133	LCD0_VDD_EN	LCD0_VDD_EN	LCD0_VDD_EN
S127	LCD0_BKLT_EN	LCD0_BKLT_EN	LCD0_BKLT_EN
S141	LCD0_BKLT_PWM	LCD0_BKLT_PWM	LCD0_BKLT_PWM
S144		DSI0_TE	eDP0_HPD

S139	I2C_LCD_CLK	I2C_LCD_CLK	I2C_LCD_CLK
S140	I2C_LCD_DAT	I2C_LCD_DAT	I2C_LCD_DAT

Pin #	LVDS Name	MIPI DSI Name	eDP Name
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S111	LVDS1_0+	DSI1_D0+	eDP1_TX0+
S112	LVDS1_0-	DSI1_D0-	eDP1_TX0-
S114	LVDS1_1+	DSI1_D1+	eDP1_TX1+
S115	LVDS1_1-	DSI1_D1-	eDP1_TX1-
S117	LVDS1_2+	DSI1_D2+	eDP1_TX2+
S118	LVDS1_2-	DSI1_D2-	eDP1_TX2-
S120	LVDS1_3+	DSI1_D3+	eDP1_TX3+
S121	LVDS1_3-	DSI1_D3-	eDP1_TX3-
S108	LVDS1_CLK+	DSI1_CLK+	eDP1_AUX+
S109	LVDS1_CLK-	DSI1_CLK-	eDP1_AUX-
S116	LCD1_VDD_EN	LCD1_VDD_EN	LCD1_VDD_EN
S107	LCD1_BKLT_EN	LCD1_BKLT_EN	LCD1_BKLT_EN
S122	LCD1_BKLT_PWM	LCD1_BKLT_PWM	LCD1_BKLT_PWM
S113		DSI1_TE	eDP1_HPD



Note:

1. LVDS0/LVDS1 are standard supported on the module.
2. DSI0 can be used but will disable the LVDS0 port, DSI1 is not supported.

4.3.1.1 LVDS0/LVDS1 mode

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
LVDS0_0+ LVDS0_0- LVDS0_1+ LVDS0_1 - LVDS0_2+ LVDS0_2- LVDS0_3+ LVDS0_3-	S125 S126 S128 S129 S131 S132 S137 S138	Primary LVDS channel differential pair data lines	O LVDS LCD		Runtime		
LVDS0_CK+ LVDS0_CK-	S134 S135	Primary LVDS channel differential pair clock lines	O LVDS LCD		Runtime		
LCD0_VDD_EN	S133	Primary LVDS channel power enable, active high	O CMOS	1.8V	Runtime		
LCD0_BKLT_EN	S127	Primary LVDS channel backlight enable, active high	O CMOS	1.8V	Runtime		
LCD0_BKLT_PWM	S141	Primary LVDS channel brightness control through pulse width modulation (PWM)	O CMOS	1.8V	Runtime		
LVDS1_0+ LVDS1_0- LVDS1_1+ LVDS1_1 - LVDS1_2+ LVDS1_2- LVDS1_3+ LVDS1_3-	S111 S112 S114 S115 S117 S118 S120 S121	Secondary LVDS channel differential pair data lines	O LVDS LCD		Runtime		
LVDS1_CK+ LVDS1_CK-	S108 S109	Secondary LVDS channel differential pair clock lines.	O LVDS LCD		Runtime		
LCD1_VDD_EN	S116	Secondary panel power enable, active high	O CMOS	1.8V	Runtime		
LCD1_BKLT_EN	S107	Secondary panel backlight enable, active high	O CMOS	1.8V	Runtime		

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
LCD1_BKLT_PWM	S122	Secondary panel brightness control through pulse width modulation (PWM)	O CMOS	1.8V	Runtime		
I2C_LCD_DAT	S140	DDC data line used for flat panel detection and control	I/O OD CMOS	1.8V	Runtime	PU 2k2	
I2C_LCD_CLK	S139	DDC clock line used for flat panel detection and control	O OD CMOS	1.8V	Runtime	PU 2k2	

4.3.1.2 DSI mode

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
DSI0_D0+ DSI0_D0- DSI0_D1+ DSI0_D1- DSI0_D2+ DSI0_D2- DSI0_D3+ DSI0_D3-	S125 S126 S128 S129 S131 S132 S137 S138	Primary DSI panel differential pair data lines	O LVDS D-PHY		Runtime		Build option
DSI0_CLK+ DSI0_CLK-	S134 S135	Primary DSI panel differential pair clock lines.	O LVDS D-PHY		Runtime		Build option
LCD0_VDD_EN	S133	Primary panel power enable, active high	O CMOS	1.8V	Runtime		
LCD0_BKLT_EN	S127	Primary panel backlight enable, active high	O CMOS	1.8V	Runtime		
LCD0_BKLT_PWM	S141	Primary panel brightness control through pulse width modulation (PWM)	O CMOS	1.8V	Runtime		
DSI0_TE	S144	Primary DSI panel tearing effect signal	I CMOS	1.8V	Runtime	PD 1M	
I2C_LCD_DAT	S140	DDC data line used for flat panel detection and control	I/O OD CMOS	1.8V	Runtime	PU 2k2	
I2C_LCD_CLK	S139	DDC clock line used for flat panel detection and control	O OD CMOS	1.8V	Runtime	PU 2k2	

4.3.2 Second & Third Display Interfaces

Pin #	HDMI signal names	DP++ signal names
P92	HDMI_D2+	DP1_LANE0+
P93	HDMI_D2-	DP1_LANE0-
P95	HDMI_D1+	DP1_LANE1+
P96	HDMI_D1-	DP1_LANE1-
P98	HDMI_D0+	DP1_LANE2+
P99	HDMI_D0-	DP1_LANE2-
P101	HDMI_CK+	DP1_LANE3+
P102	HDMI_CK-	DP1_LANE3-
S105	HDMI_CTRL_CK	DP1_AUX+
S106	HDMI_CTRL_DAT	DP1_AUX-
P104	HDMI_HPD	DP1_HPD
P107	-	DP1_AUX_SEL

Pin #	DP++ signal names
P92	DP0_LANE0+
P93	DP0_LANE0-
P95	DP0_LANE1+
P96	DP0_LANE1-
P98	DP0_LANE2+
P99	DP0_LANE2-
P101	DP0_LANE3+
P102	DP0_LANE3-
S105	DP0_AUX+
S106	DP0_AUX-
P104	DP0_HPD
P107	DP0_AUX_SEL



Note: DisplayPort is not supported on both second and third display interfaces

4.3.2.1 HDMI

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
HDMI_D2+ HDMI_D2- HDMI_D1+ HDMI_D1- HDMI_D0+ HDMI_D0-	P92 P93 P95 P96 P98 P99	HDMI port, differential pair data lines	O TMDS HDMI		Runtime		
HDMI_CK+ HDMI_CK-	P101 P102	HDMI port, differential pair clock lines	O TMDS HDMI		Runtime		
HDMI_CTRL_CK	P105	I2C_CLK line dedicated to HDMI	O OD COMS	1.8V	Runtime	PU 100K	Level shifter FET and 5V PU resistor shall be placed between the module and the HDMI connector.
HDMI_CTRL_DAT	P106	I2C_DAT line dedicated to HDMI	I/O OD COMS	1.8V	Runtime	PU 100K	Level shifter FET and 5V PU resistor shall be placed between the module and the HDMI connector.
HDMI_HPD	P104	HDMI Hot plug active high detection signal that serves as an interrupt request	I CMOS	1.8V	Runtime	PD 1M	Module must tolerate high level in stand-by mode

4.3.3 MIPI Camera Support

4.3.3.1 MIPI CSIO

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
CSIO_RX0+ CSIO_RX0- CSIO_RX1+ CSIO_RX1-	S11 S12 S14 S15	CSIO differential input (point to point)	I LVDS D-PHY / I LVDS M-PHY		Runtime		
CSIO_CK+ CSIO_CK-	S8 S9	CSIO differential clock input (point to point)	I LVDS D-PHY		Runtime		
I2C_CAM0_DAT / CSIO_TX-	S7	I2C data for serial camera data support link or differential data lane	I/O OD CMOS / O LVDS M-PHY	1.8V	Runtime	PU 2.2K	MIPI-CSI 2.0 uses I2C_CAM0_DAT MIPI-CSI 3.0 uses CSIO_TX-
I2C_CAM0_CK / CSIO_TX+	S5	I2C clock for serial camera data support link or differential data lane	O OD CMOS / O LVDS M-PHY	1.8V	Runtime	PU 2.2K	MIPI-CSI 2.0 uses I2C_CAM0_CK MIPI-CSI 3.0 uses CSIO_TX+
CAM0_PWR# / GPIO0	P108	Camera 0 Power Enable, active low output.	O CMOS	1.8V	Runtime		
CAM0_RST# / GPIO2	P110	Camera 0 reset, active low output	O CMOS	1.8V	Runtime		
CAM_MCK	S6	Master clock output	O CMOS	1.8V	Runtime		This signal is used by both CSIO and CSI1

4.3.3.2 MIPI CSI1 (Camera)

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
CSI1_RX0+ CSI1_RX0- CSI1_RX1+ CSI1_RX1- CSI1_RX2+ CSI1_RX2- CSI1_RX3+ CSI1_RX3-	P7 P8 P10 P11 P13 P14 P16 P17	CSI1 differential input (point to point)	I LVDS D-PHY / I LVDS M-PHY		Runtime		
CSI1_CK+ CSI1_CK-	P3 P4	CSI1 differential clock input (point to point)	I LVDS D-PHY		Runtime		
I2C_CAM1_DAT / CSI1_TX-	S2	I2C data for serial camera data support link or differential data lane	I/O OD CMOS / O LVDS M-PHY	1.8V	Runtime	PU 2.2K	MIPI-CSI 2.0 mode uses I2C_CAM1_DAT MIPI-CSI 3.0 mode uses CSI1_TX-
I2C_CAM1_CK / CSI1_TX+	S1	I2C clock for serial camera data support link or differential data lane	O OD CMOS / O LVDS M-PHY	1.8V	Runtime	PU 2.2K	MIPI-CSI 2.0 mode uses I2C_CAM1_CK MIPI-CSI 3.0 mode uses CSI1_TX+
CAM1_PWR# / GPIO1	P109	Camera 0 Power Enable, active low output.	O CMOS	1.8V	Runtime		CAM1_PWR# is default, GPIO1 can be enabled through DVT
CAM1_RST# / GPIO3	P111	Camera 0 reset, active low output	O CMOS	1.8V	Runtime		CAM1_PWR# is default, GPIO3 can be enabled through DVT
CAM_MCK	S6	Master clock output	O CMOS	1.8V	Runtime		This signal is used by both CSI0 and CSI1

4.3.4 I2S (Audio)

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
I2S0_LRCK	S39	I2S0 Left & Right synchronization clock	I/O CMOS	1.8V	Runtime		Module Output if CPU acts in Master Mode Module Input if CPU acts in Slave Mode
I2S0_SDOUT	S40	I2S0 Digital audio Output	O CMOS	1.8V	Runtime		
I2S0_SDIN	S41	I2S0 Digital audio Input	I CMOS	1.8V	Runtime		
I2S0_CK	S42	I2S0 Digital audio clock	I/O CMOS	1.8V	Runtime		Module Output if CPU acts in Master Mode Module Input if CPU acts in Slave Mode
I2S2_LRCK	S50	I2S2 Left & Right synchronization clock	I/O CMOS	1.8V	Runtime	-	Module Output if CPU acts in Master Mode Module Input if CPU acts in Slave Mode
I2S2_SDOUT	S51	I2S2 Digital audio Output	O CMOS	1.8V	Runtime	-	-
I2S2_SDIN	S52	I2S2 Digital audio Input	I CMOS	1.8V	Runtime	-	-
I2S2_CK	S53	I2S2 Digital audio clock	I/O CMOS	1.8V	Runtime	-	Module Output if CPU acts in Master Mode Module Input if CPU acts in Slave Mode
AUDIO_MCK	S38	Master clock output to I2S codec(s)	O CMOS	1.8V	Runtime	-	-



Note: support for I2S1 signalling pins has been removed during update to SMARC 2.0 specification

4.3.5 USB Ports

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
USB0+ USB0-	P60 P61	USB differential data pairs for port 0	I/O USB	USB	Standby		From SOC
USB0_EN_OC#	P62	USB over-current sense for port 0	I/O OD CMOS	3.3Vsb / 3.3V	Standby	PU 10k	Pulled low by Module OD driver to disable USB0 power. Pulled low by Carrier OD driver to indicate over-current situation.
USB0_VBUS_DET	P63	USB port 0 host power detection, when this port is used as a device.	I USB VBUS 5V	USB VBUS 5V	Standby		Can be connected to a USB client port VBUS pin
USB0_OTG_ID	P64	Input pin to announce OTG device insertion on USB 2.0 port	I CMOS	3.3Vsb / 3.3V	Standby		
USB1+ USB1-	P65 P66	USB differential data pairs for port 1	I/O USB	USB	Standby		From USB HUB
USB1_EN_OC#	P67	USB over-current sense for port 1	I/O OD CMOS	3.3Vsb / 3.3V	Standby	PU 10k	Pulled low by Module OD driver to disable USB0 power. Pulled low by Carrier OD driver to indicate over-current situation.
USB2+ USB2-	P69 P70	USB differential data pairs for port 2	I/O USB	USB	Standby		From USB HUB
USB2_SSRX+ USB2_SSRX-	S74 S75	Receive signal differential pairs for SuperSpeed on port 2	I USB SS	USB SS	Standby	-	
USB2_SSTX+ USB2_SSTX-	S71 S72	Transmit signal differential pairs for SuperSpeed on port 2	O USB SS	USB SS	Standby	-	
USB2_EN_OC#	P71	USB over-current sense for port 2	I/O OD CMOS	3.3Vsb / 3.3V	Standby	PU 10k	Pulled low by Module OD driver to disable USB0 power. Pulled low by Carrier OD driver to indicate over-current situation.

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
USB3+ USB3-	S68 S69	USB differential data pairs for port 3	I/O USB	USB	Standby		From USB HUB
USB3_SSRX+ USB3_SSRX-	S65 S66	Receive signal differential pairs for SuperSpeed on port 3	I USB SS	USB SS	Standby		
USB3_SSTX+ USB3_SSTX-	S62 S63	Transmit signal differential pairs for SuperSpeed on port 3	O USB SS	USB SS	Standby		
USB3_EN_OC#	P74	USB over-current sense for port 3	I/O OD CMOS	3.3Vsb / 3.3V	Standby	PU 10k	Pulled low by Module OD driver to disable USB0 power. Pulled low by Carrier OD driver to indicate over-current situation.
USB3_VBUS_DET	S37	USB port 3 host power detection, when this port is used as a device.	+ USB VBUS 5V	USB VBUS 5V	Standby	-	-
USB3_OTG_ID	S104	Input pin to announce OTG device insertion on USB 3.0 port	+ CMOS	3.3Vsb / 3.3V	Standby	-	-

USB4+ USB4-	S35 S36	USB differential data pairs for port 4	I/O USB	USB	Standby		
USB4_EN_OC#	P76	USB over-current sense for port 4	I/O OD CMOS	3.3Vsb / 3.3V	Standby	PU 10k	Pulled low by Module OD driver to disable USB0 power. Pulled low by Carrier OD driver to indicate over-current situation.

USB5+ USB5-	S59 S60	USB differential data pairs for port 5	I/O USB	USB	Standby		
USB5_EN_OC#	S55	USB over-current sense for port 5	I/O OD CMOS	3.3Vsb / 3.3V	Standby	PU 10k	Pulled low by Module OD driver to disable USB0 power. Pulled low by Carrier OD driver to indicate over-current situation.

**Note:**

1. USB0 is directly connected to the SoC. USB1/2/3/4/5 share bandwidth through a HUB.
2. Extreme rugged (-ER) parts have no USB hub populated.

4.3.6 PCIe Ports

The module supports 2x PCIe Gen 2.1 ports (PCIE_A and PCIE_B).

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
PCIE_A_TX+ PCIE_A_TX-	P89 P90	Differential PCIe link A transmit data pair	O LVDS PCIE		Runtime		Series AC coupled on module
PCIE_A_RX+ PCIE_A_RX-	P86 P87	Differential PCIe link A receive data pair	I LVDS PCIE		Runtime		Series AC coupled off module
PCIE_A_REFCK+ PCIE_A_REFCK-	P83 P84	Differential PCIe Link A reference clock output	O LVDS PCIE		Runtime		
PCIE_A_RST#	P75	PCIe Port A reset output	O CMOS	3.3V	Runtime		
PCIE_A_CKREQ#	P78	PCIe Port A clock request	I OD CMOS	3.3V	Runtime	PU > 10K	No need for this signal because module provides onboard PCIe clock

PCIE_B_TX+ PCIE_B_TX-	S90 S91	Differential PCIe link B transmit data pair	O LVDS PCIE		Runtime		Series AC coupled on module
PCIE_B_RX+ PCIE_B_RX-	S87 S88	Differential PCIe link B receive data pair	I LVDS PCIE		Runtime		Series AC coupled off module
PCIE_B_REFCK+ PCIE_B_REFCK-	S84 S85	Differential PCIe Link B reference clock output	O LVDS PCIE		Runtime		
PCIE_B_RST#	S76	PCIe Port B reset output	O CMOS	3.3V	Runtime		
PCIE_B_CKREQ#	P77	PCIe Port B clock request	I OD CMOS	3.3V	Runtime	PU > 10K	No need for this signal because module provides onboard PCIe clock

PCIE_C_TX+ PCIE_C_TX-	S81 S82	Differential PCIe link C transmit data pair	O LVDS PCIE	-	Runtime	-	Series AC coupled on module
PCIE_C_RX+ PCIE_C_RX-	S78 S79	Differential PCIe link C receive data pair	I LVDS PCIE	-	Runtime	-	Series AC coupled off module
PCIE_C_REFCK+ PCIE_C_REFCK-	P80 P81	Differential PCIe Link C reference clock output	O LVDS PCIE	-	Runtime	-	-

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
PCIE_C_RST#	S77	PCle Port C reset output	0-CMOS	3.3V	Runtime	-	-
PCIE_D_TX+ PCIE_D_TX-	S29 S30	Differential PCle link D transmit data pair	0-LVDS -PCIE	-	Runtime	-	Series AC-coupled on module
PCIE_D_RX+ PCIE_D_RX-	S32 S33	Differential PCle link D receive data pair	1-LVDS -PCIE	-	Runtime	-	Series AC-coupled off module
PCIE_WAKE#	S146	PCle wake up interrupt to host – common to PCle links A, B, C, D	1 OD CMOS	3.3V	Runtime	PU 10k	

 **Note:** Module provides PCle clock generators for PCIE_A and PCIE_B so no external clock source on the carrier is needed

4.3.7 SATA Ports

This design does not support SATA ports

4.3.8 LAN Ports

4.3.8.1 First LAN Port

The first LAN port is derived from the SoC's RGMII0 interface

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments																				
GBE0_MDI0+ GBE0_MDI0- GBE0_MDI1+ GBE0_MDI1- GBE0_MDI2+ GBE0_MDI2- GBE0_MDI3+ GBE0_MDI3-	P30 P29 P27 P26 P24 P23 P20 P19	Gigabit Ethernet Controller 0: Media Dependent Interface Differential Pairs 0, 1, 2, 3. The MDI can operate in 1000, 100, and 10Mbit/sec modes. Some pairs are unused in some modes according to the following: <table><tr><td></td><td>1000</td><td>100</td><td>10</td></tr><tr><td>MDI[0]+/-</td><td>B1_DA+/-</td><td>TX+/-</td><td>TX+/-</td></tr><tr><td>MDI[1]+/-</td><td>B1_DB+/-</td><td>RX+/-</td><td>RX+/-</td></tr><tr><td>MDI[2]+/-</td><td>B1_DC+/-</td><td></td><td></td></tr><tr><td>MDI[3]+/-</td><td>B1_DD+/-</td><td></td><td></td></tr></table>		1000	100	10	MDI[0]+/-	B1_DA+/-	TX+/-	TX+/-	MDI[1]+/-	B1_DB+/-	RX+/-	RX+/-	MDI[2]+/-	B1_DC+/-			MDI[3]+/-	B1_DD+/-			GBE MDI		Standby		Twisted pair signals for external transformer.
	1000	100	10																								
MDI[0]+/-	B1_DA+/-	TX+/-	TX+/-																								
MDI[1]+/-	B1_DB+/-	RX+/-	RX+/-																								
MDI[2]+/-	B1_DC+/-																										
MDI[3]+/-	B1_DD+/-																										
GBE0_LINK100#	P21	Link Speed Indication LED for GBE 0 100Mbps	O OD CMOS	3.3V	Standby		Shall be able to sink 24mA or more Carrier LED current																				
GBE0_LINK1000#	P22	Link Speed Indication LED for GBE 0 1000Mbps	O OD CMOS	3.3V	Standby		Shall be able to sink 24mA or more Carrier LED current																				
GBE0_LINK_ACT#	P25	Link / Activity Indication LED Driven low on Link (10, 100 or 1000 mbps) Blinks on Activity	O OD CMOS	3.3V	Standby		Shall be able to sink 24mA or more Carrier LED current																				
GBE0_CTREF	P28	Center-Tap reference voltage for Carrier board Ethernet magnetic (if required by the Module GBE PHY)	Analog	0 to 3.3V max	Standby	-	-																				
GBE0_SDP	P6	IEEE 1588 Trigger Signal. For hardware implementation of PTP (precision time protocol)	IO CMOS	3.3V	Standby																						

4.3.8.2 Second LAN Port

The Second LAN port is derived from the SoC's RGMII1 interface

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
GBE1_MDI0+ GBE1_MDI0- GBE1_MDI1+ GBE1_MDI1- GBE1_MDI2+ GBE1_MDI2- GBE1_MDI3+ GBE1_MDI3-	S17 S18 S20 S21 S23 S24 S26 S27	Gigabit Ethernet Controller 1: Media Dependent Interface Differential Pairs 0, 1, 2, 3. The MDI can operate in 1000, 100, and 10Mbit/sec modes. Some pairs are unused in some modes according to the following: 1000 100 10 MDI[0]+/- B1_DA+/- TX+/- TX+/- MDI[1]+/- B1_DB+/- RX+/- RX+/- MDI[2]+/- B1_DC+/- MDI[3]+/- B1_DD+/-	GBE MDI		Standby		Twisted pair signals for external transformer.
GBE1_LINK100#	S19	Link Speed Indication LED for GBE 1 100Mbps	O OD CMOS	3.3V	Standby		Shall be able to sink 24mA or more Carrier LED current
GBE1_LINK1000#	S22	Link Speed Indication LED for GBE 1 1000Mbps	O OD CMOS	3.3V	Standby		Shall be able to sink 24mA or more Carrier LED current
GBE1_LINK_ACT#	S31	Link / Activity Indication LED Driven low on Link (10, 100 or 1000 mbps) Blinks on Activity	O OD CMOS	3.3V	Standby		Shall be able to sink 24mA or more Carrier LED current
GBE1_CTREF	S28	Center-Tap reference voltage for Carrier board Ethernet magnetic `(if required by the Module GBE PHY)`	Analog	0 to 3.3V max	Standby		
GBE1_SDP	P5	IEEE 1588 Trigger Signal. For hardware implementation of PTP (precision time protocol)	IO CMOS	3.3V	Standby		

4.3.9 SDIO

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
SDIO_D0 SDIO_D1 SDIO_D2 SDIO_D3	P39 P40 P41 P42	SDIO Data lines. These signals operate in push-pull mode.	I/O CMOS	1.8V or 3.3V	Runtime		SDIO controller will detect SD Cards voltage level (1.8V for UHS-I and 3.3V for standard) and adjust its I/O voltage level accordingly
SDIO_WP	P33	SDIO Write Protect. This signal denotes the state of the write-protect tab on SD cards.	I OD CMOS	3.3V	Runtime	PU 10k	Pulled up on module
SDIO_CMD	P34	SDIO Command/Response. This signal is used for card initialization and for command transfers. During initialization mode this signal is open drain. During command transfer this signal is in push-pull mode.	I/O CMOS	1.8V or 3.3V	Runtime		SDIO controller will detect SD Cards voltage level (1.8V for UHS-I and 3.3V for standard) and adjust its I/O voltage level accordingly
SDIO_CD#	P35	SDIO Card Detect. This signal indicates when a SDIO/MMC card is present.	I OD CMOS	3.3V	Runtime	PU 10k	Pulled up on module
SDIO_CK	P36	SDIO Clock. With each cycle of this signal a one-bit transfer on the command and each data line occurs.	O CMOS	1.8V or 3.3V	Runtime		
SDIO_PWR_EN	P37	SDIO Power Enable. This signal is used to enable the power being supplied to a SD/MMC card device.	O CMOS	3.3V	Runtime		should be driven low in STB Mode by the module

4.3.10 SPI and ESPI

4.3.10.1 SPI0

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
SPI0_CS0#	P43	SPI0 Master Chip Select 0	O CMOS	1.8V	Standby		This signal can be used to select carrier SPI as boot device
SPI0_CS1#	P31	SPI0 Master Chip Select 1	Ø CMOS	1.8V	Standby		
SPI0_CK	P44	SPI0 Clock	O CMOS	1.8V	Standby		
SPI0_DIN	P45	SPI0 Master input / Slave output	I CMOS	1.8V	Standby		also referred to as MISO
SPI0_DO	P46	SPI0 Master output / Slave input	O CMOS	1.8V	Standby		also referred to as MOSI

SPI1_CS0#	P54	SPI1 Master Chip Select 0	O CMOS	1.8V	Standby	-	See ESPI
SPI1_CS1#	P55	SPI1 Master Chip Select 1	Ø CMOS	1.8V	Standby	-	See ESPI
SPI1_CK	P56	SPI1 Clock	O CMOS	1.8V	Standby	-	See ESPI
SPI1_DIN	P57	SPI1 Master input / Slave output	I CMOS	1.8V	Standby	-	See ESPI
SPI1_DO	P58	SPI1 Master output / Slave input	O CMOS	1.8V	Standby	-	See ESPI



Note: SPI0/1 is free to use on the carrier.

4.3.10.2 ESPI

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
ESPI_CS0#	P54	ESPI1 Master Chip Select 0	0 CMOS	1.8V	Standby	-	
ESPI_CS1#	P55	ESPI1 Master Chip Select 1	0 CMOS	1.8V	Standby	-	
ESPI_CK	P56	ESPI Master Clock output	0 CMOS	1.8V	Standby	-	
ESPI_RESET#	S58	ESPI Reset	0 CMOS	1.8V	Standby	-	Reset the eSPI interface for both master and slaves. eSPI Reset# is typically driven from eSPI master to eSPI slaves
ESPI_ALERT0# ESPI_ALERT1#	S43 S44	ESPI ALERT	1-0 CMOS	1.8V	Standby	-	This pin is used by eSPI slave to request service from eSPI master. Alert# is an open-drain output from the slave. This pin is optional for Single Master-Single Slave configuration where I/O[1] can be used to signal the Alert event.
ESPI_IO_0 ESPI_IO_1 ESPI_IO_2 ESPI_IO_3	P58 P57 S56 S57	ESPI Master Data Input / Output.	I/O CMOS	1.8V	Standby	-	ESPI_IO_0 can also be used as SPI1_DO (MOSI) ESPI_IO_1 can also be used as SPI1_DIN (MISO) In Single I/O mode, ESPI_IO_0 is the eSPI master output / eSPI slave input (MOSI) whereas ESPI_IO_1 is the SPI master input / eSPI slave output (MISO).



Note: On NXP i.MX8M Plus, part SPI is used

4.4 General Purpose I2C

The SMARC specification supports a total of 6 different I2C busses on its pinout. Most of these busses are designated for specific functions such as I2C for camera management, I2C for EDID on HDMI, LVDS panels or I2C for PMIC. Only one I2C bus is marked as General purpose

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
I2C_GP_DAT	S49	General purpose I2C data signal	I/O OD CMOS	1.8V	Runtime	PU 2k2	
I2C_GP_CK	S48	General purpose I2C clock signal	O OD CMOS	1.8V	Runtime	PU 2k2	

Most of the other I2C busses are described in their designated function tables as opposed to a combined list.

Below is an overview of all I2C busses and where to find them.

Name	Pin #	Description	Where to find
I2C_LCD_DAT	S140	DDC data line used for flat panel detection and control	LVDS / DSI / eDP tables
I2C_LCD_CK	S139	DDC clock line used for flat panel detection and control	LVDS / DSI / eDP tables
HDMI_CTRL_CK	P105	I2C_CLK line dedicated to HDMI	HDMI table
HDMI_CTRL_DAT	P106	I2C_DAT line dedicated to HDMI	HDMI table
I2C_CAM0_DAT	S7	I2C data for serial camera data support link	MIPI CSI table
I2C_CAM0_CK	S5	I2C clock for serial camera data support link	MIPI CSI table
I2C_CAM1_DAT	S2	I2C data for serial camera data support link	MIPI CSI table
I2C_CAM1_CK	S1	I2C clock for serial camera data support link	MIPI CSI table
I2C_PM_DAT	P122	Power management I2C bus DATA (SMBus for x86)	Power and System Management
I2C_PM_CK	P121	Power management I2C bus CLK (SMBus for x86)	Power and System Management

4.4.1 GPIO

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
GPIO0 / CAM0_PWR#	P108	General purpose I/O pin 0.	I/O CMOS	1.8V	Runtime	PU 470K on the Module.	Default use is GPIO0, alternative use is Camera 0 Power Enable - active low, through DTS
GPIO1 / CAM1_PWR#	P109	General purpose I/O pin 1.	I/O CMOS	1.8V	Runtime	PU 470K on the Module	Default use is is GPIO1 alternative use is Camera 1 Power Enable - active low, through DTS
GPIO2 / CAM0_RST#	P110	General purpose I/O pin 2.	I/O CMOS	1.8V	Runtime	PU 470K on the Module	Default use is GPIO2, alternative use is Camera 0 Reset - active low, through DTS
GPIO3 / CAM1_RST#	P111	General purpose I/O pin 3.	I/O CMOS	1.8V	Runtime	PU 470K on the Module	Default use is GPIO3, alternative use is Camera 1 Reset - active low, through DTS
GPIO4 / HDA_RST#	P112	General purpose I/O pin 4.	I/O CMOS	1.8V	Runtime	PU 470K on the Module	
GPIO5 / PWM_OUT	P113	General purpose I/O pin 5.	I/O CMOS	1.8V	Runtime	PU 470K on the Module	
GPIO6 / TACHIN	P114	General purpose I/O pin 6.	I/O CMOS	1.8V	Runtime	PU 470K on the Module	
GPIO7	P115	General purpose I/O pin 7.	I/O CMOS	1.8V	Runtime	PU 470K on the Module	
GPIO8	P116	General purpose I/O pin 8.	I/O CMOS	1.8V	Runtime	PU 470K on the Module	
GPIO9	P117	General purpose I/O pin 9.	I/O CMOS	1.8V	Runtime	PU 470K on the Module	
GPIO10	P118	General purpose I/O pin 10.	I/O CMOS	1.8V	Runtime	PU 470K on the Module	
GPIO11	P119	General purpose I/O pin 11.	I/O CMOS	1.8V	Runtime	PU 470K on the Module	
GPIO12	S142	General purpose I/O pin 12	I/O CMOS	1.8V	Runtime	PU 470K on the Module	
GPIO13	S123	General purpose I/O pin 13	I/O CMOS	1.8V	Runtime	PU 470K on the Module	

4.4.2 UART

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
SER0_TX	P129	Asynchronous serial data output port 0	O CMOS	1.8V	Runtime		
SER0_RX	P130	Asynchronous serial data input port 0	I CMOS	1.8V	Runtime		
SER0_RTS#	P131	"Request to Send" handshake line for port 0	O CMOS	1.8V	Runtime		
SER0_CTS#	P132	"Clear to Send" handshake line for port 0	I CMOS	1.8V	Runtime		
SER1_TX	P134	Asynchronous serial data output port 1	O CMOS	1.8V	Runtime		
SER1_RX	P135	Asynchronous serial data input port 1	I CMOS	1.8V	Runtime		
SER2_TX	P136	Asynchronous serial data output port 2	O CMOS	1.8V	Runtime	-	-
SER2_RX	P137	Asynchronous serial data input port 2	I CMOS	1.8V	Runtime	-	-
SER2_RTS#	P138	"Request to Send" handshake line for port 2	O CMOS	1.8V	Runtime	-	-
SER2_CTS#	P139	"Clear to Send" handshake line for port 2	I CMOS	1.8V	Runtime	-	-
SER3_TX	P140	Asynchronous serial data output port 3	O CMOS	1.8V	Runtime	-	
SER3_RX	P141	Asynchronous serial data input port 3	I CMOS	1.8V	Runtime	-	

4.4.3 CAN Bus

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
CAN0_TX	P143	CAN port 0 Transmit output	O CMOS	1.8V	Runtime		
CAN0_RX	P144	CAN port 0 Receive input	I CMOS	1.8V	Runtime		
CAN1_TX	P145	CAN port 1 Transmit output	O CMOS	1.8V	Runtime		
CAN1_RX	P146	CAN port1 Receive input	I CMOS	1.8V	Runtime		

4.4.4 Miscellaneous

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
TEST#	S157	Held low by Carrier to invoke Module vendor specific test function(s).	I CMOS	1.8V	Runtime	PU on Module. Driven by OD on Carrier	Module must implement PU but actual value is depended on particular module design. Carrier Board should leave this pin floating for normal operation
WDT_TIME_OUT#	S145	Watch-Dog-Timer Output, low active.	O CMOS	1.8V	Runtime		Driven only during runtime

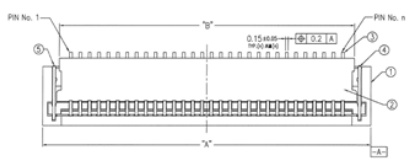
4.4.5 Power and System Management

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
BATLOW#	S156	Battery low indication to Module. Carrier to float the line in inactive state.	I OD CMOS	1.8V	Standby / Sleep	PU 10K	Driven by OD on Carrier. Pulled up on module.
CARRIER_PWR_ON	S154	Carrier board circuits (apart from power management and power path circuits) should not be powered up until the Module asserts the CARRIER_PWR_ON signal.	O CMOS	1.8Vsb / 1.8V	Standby		1.8Vsb is only used for signaling, not a power source to the module
CARRIER_STBY#	S153	The Module shall drive this signal low when the system is in a standby power state.	O CMOS	1.8Vsb / 1.8V	Standby		
CHARGER_PRSENT#	S152	Held low by Carrier if DC input for battery charger is present.	I OD CMOS	1.8V	Standby / Sleep	PU 10K	Driven by OD on Carrier. Pulled up on module.
CHARGING#	S151	Held low by Carrier during battery charging. Carrier to float the line when charge is complete.	I OD CMOS	1.8V	Standby / Sleep	PU 10K	Driven by OD on Carrier. Pulled up on module.
VIN_PWR_BAD#	S150	Power bad indication from Carrier board. Module and Carrier power supplies (other than Module and Carrier power supervisory circuits) shall not be enabled while this signal is held low by the Carrier.	I OD CMOS	1.8V	Runtime	PU 10K	Driven by OD on Carrier. Module must implement PU but actual value is depended on particular module design.
SLEEP#	S149	Sleep indicator from Carrier board. May be sourced from user Sleep button or Carrier logic. Carrier to float the line in in-active state.Active low, level sensitive. Should be de-bounced on the Module.	I OD CMOS	1.8V	Standby	PU 10K	Driven by OD on Carrier. Pulled up on module.
LID#	S148	Lid open/close indication to Module. Low indicates lid closure (which system may use to initiate a sleep state). Carrier to float the line in in-active state. Active low, level sensitive. Should be de-bounced on the Module.	I OD CMOS	1.8V	Standby	PU 10K	Driven by OD on Carrier. Pulled up on module.
POWER_BTN#	P128	Power-button input from Carrier board. Carrier to float the line in in-active state. Active low, level sensitive. Should be debounced on the Module.	I OD CMOS	1.8V	Sleep	PU 10K	Driven by OD on Carrier. Pulled up on module.

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
RESET_OUT#	P126	General purpose reset output to Carrier board.	O CMOS	1.8V	Standby		
RESET_IN#	P127	Reset input from Carrier board. Carrier drives low to force a Module reset, floats the line otherwise.	I OD CMOS	1.8V	Standby	PU 10K	Driven by OD on Carrier. Pulled up on module.
I2C_PM_DAT	P122	Power management I2C bus DATA	I/O OD CMOS	1.8V	Standby / Sleep	PU 2k2	On x86 systems these serve as SMB DATA. Pulled up on module.
I2C_PM_CLK	P121	Power management I2C bus CLK	O OD CMOS	1.8V	Standby / Sleep	PU 2k2	On x86 systems these serve as SMB CLK. Pulled up on module.
SMB_ALERT_1V8#	P1	SMBus Alert# (interrupt) signal	I OD CMOS	1.8V	Standby / Sleep	PU 2k2	only used on x86 design

4.4.6 DB30 Multipurpose Connector

FPC Connector: HIROSE, FH12-30S-0.5SH(55)



DB30 connector brings out the following type of signals

SPI0 bus

JTAG to SOC

Boot Select strap pins

BMC programming interface

Serial port

4.4.7 Boot Select

Name	Pin #	Description	I/O Type	I/O Level	Power Domain	PU / PD	Comments
BOOT_SEL0# BOOT_SEL1# BOOT_SEL2#	P123 P124 P125	Input straps determine the Module boot	I OD CMOS	1.8Vsb	Standby	PU 10K	Driven by OD on Carrier. Pulled up on module. Only booting from EMMC and SDcard is supported
FORCE_RECOV#	S155		I OD CMOS	1.8Vsb	Standby	PU 10K	Driven by OD on Carrier. Pulled up on module. Low on this pin allows non-protected segments of Module boot device to be rewritten / restored from an external USB Host on Module USB0. The Module USB0 operates in Client Mode when in the Force Recovery function is invoked. Pulled high on the Module. For SOC's that do not implement a USB based Force Recovery functions, then a low on the Module FORCE_RECOV# pin may invoke the SOC native Force Recovery mode – such as over a Serial Port. For x86 systems this signal may be used to load BIOS defaults. Pulled up on Module. Driven by OD part on Carrier.

4.4.8 Power

Name	Pin #	Description	I/O Type	Power Rail / Tolerance	PU / PD	Comments
VDD_IN	P147, P148, P149, P150, P151, P152, P153, P154, P155, P156	Module power input voltage 4.75 min to 5.25V max	P Not defined within Signal Terminolgy Descriptions. Should we define a specific rail?	3 to 5.25V / 5V		
GND	P2, P9, P12, P15, P18, P32, P38, P47, P50, P53, P59, P68, P79, P82, P85, P88, P91, P94, P97, P100, P103, P120, P133, P142, S3, S10, S16, S25, S34, S47, S61, S64, S67, S70, S73, S80, S83, S86, S89, S92, S101, S110, S119, S124, S130, S136, S143, S158	Module signal and power return, and GND reference	P Not defined within Signal Terminolgy Descriptions. Should we define a specific rail?	Ground		
VDD_RTC	S147	Low current RTC circuit backup power – 3.0V nominal. May be sourced from a Carrier based Lithium cell or Super Cap.	P Not defined within Signal Terminolgy Descriptions. Should we define a specific rail?	[2 to 3.25] / 3.25V		

4.5 SMARC Pin-to-controller Mapping

	SMARC Signal Name	Module Direction	Module Termination	Type/Tolerance	Controller	Controller Pin Name	I/O Mux default	Power Rail
P1	SMB_ALERT_1V8#	In	-	GPIO / 1.8V	i.MX8Mplus	SAI5_RXC	-	NVCC_SAI1_SAI5
P2	GND	-	-	-	-	-	-	-
P3	CSI1_CK+	In	-	LVDS D-PHY	i.MX8Mplus	MIPI_CSI2_CLK_P	-	CSI_P2_VDDHA
P4	CSI1_CK-	In	-	LVDS D-PHY	i.MX8Mplus	MIPI_CSI2_CLK_N	-	CSI_P2_VDDHA
P5	GBE1_SDP	Out	-	GPIO/3.3V	DP83867	CLK_OUT		
P6	GBE0_SDP	Out	-	GPIO/3.3V	DP83867	CLK_OUT		
P7	CSI1_RX0+	In	-	LVDS D-PHY	i.MX8Mplus	MIPI_CSI2_D0_P	-	CSI_P2_VDDHA
P8	CSI1_RX0-	In	-	LVDS D-PHY	i.MX8Mplus	MIPI_CSI2_D0_N	-	CSI_P2_VDDHA
P9	GND	-	-	-	-	-		
P10	CSI1_RX1+	In	-	LVDS D-PHY	i.MX8Mplus	MIPI_CSI2_D1_P	-	CSI_P2_VDDHA
P11	CSI1_RX1-	In	-	LVDS D-PHY	i.MX8Mplus	MIPI_CSI2_D1_N	-	CSI_P2_VDDHA
P12	GND	-	-	-	-	-		
P13	CSI1_RX2+	In	-	LVDS D-PHY	i.MX8Mplus	MIPI_CSI2_D2_P	-	CSI_P2_VDDHA
P14	CSI1_RX2-	In	-	LVDS D-PHY	i.MX8Mplus	MIPI_CSI2_D2_N	-	CSI_P2_VDDHA
P15	GND	-	-	-	-	-		
P16	CSI1_RX3+	In	-	LVDS D-PHY	i.MX8Mplus	MIPI_CSI2_D3_P	-	CSI_P2_VDDHA
P17	CSI1_RX3-	In	-	LVDS D-PHY	i.MX8Mplus	MIPI_CSI2_D3_N	-	CSI_P2_VDDHA
P18	GND	-	-	-	-	-	-	-
P19	GBE0_MDI3-	Bi-Dir	-	GBE MDI	DP83867	TD_M_D	-	VDDIO
P20	GBE0_MDI3+	Bi-Dir	-	GBE MDI	DP83867	TD_P_D	-	VDDIO
P21	GBE0_LINK100#	Out/OD	-	GPIO / 3.3V	DP83867	LED_1	-	VDDIO
P22	GBE0_LINK1000#	Out/OD	-	GPIO / 3.3V	DP83867	LED_2	-	VDDIO
P23	GBE0_MDI2-	Bi-Dir	-	GBE MDI	DP83867	TD_M_C	-	VDDIO
P24	GBE0_MDI2+	Bi-Dir	-	GBE MDI	DP83867	TD_P_C	-	VDDIO
P25	GBE0_LINK_ACT#	Out/OD	-	GPIO / 3.3V	DP83867	LED_0	-	VDDIO
P26	GBE0_MDI1-	Bi-Dir	-	GBE MDI	DP83867	TD_M_B	-	VDDIO

	SMARC Signal Name	Module Direction	Module Termination	Type/Tolerance	Controller	Controller Pin Name	I/O Mux default	Power Rail
P26	GBE0_MDI1-	Bi-Dir	-	GBE MDI	DP83867	TD_M_B	-	VDDIO
P27	GBE0_MDI1+	Bi-Dir	-	GBE MDI	DP83867	TD_P_B	-	VDDIO
P28	GBE0_CTREF	PWR	-	-	-	-	-	-
P29	GBE0_MDI0-	Bi-Dir	-	GBE MDI	DP83867	TD_M_A	-	VDDIO
P30	GBE0_MDI0+	Bi-Dir	-	GBE MDI	DP83867	TD_P_A	-	VDDIO
P31	SPI0_CS1#	-	-	-	N.C.	N.C.	-	-
P32	GND	-	-	-	-	-	-	-
P33	SDIO_WP	In	-	SD2 / 3.3V	i.MX8Mplus	SD2_WP	ALT0	NVCC_SD2
P34	SDIO_CMD	Bi-Dir	-	SD2 / 3.3V	i.MX8Mplus	SD2_CMD	ALT0	NVCC_SD2
P35	SDIO_CD#	In	-	SD2 / 3.3V	i.MX8Mplus	SD2_CD	ALT0	NVCC_SD2
P36	SDIO_CLK	Out	-	SD2 / 3.3V	i.MX8Mplus	SD2_CLK	ALT0	NVCC_SD2
P37	SDIO_PWR_EN	Out	-	GPIO / 3.3V	i.MX8Mplus	GPIO1_IO12	ALT0	NVCC_GPIO1
P38	GND	-	-	-	-	-	-	-
P39	SDIO_D0	Bi-Dir	-	SD2 / 3.3V	i.MX8Mplus	SD2_DATA0	ALT0	NVCC_SD2
P40	SDIO_D1	Bi-Dir	-	SD2 / 3.3V	i.MX8Mplus	SD2_DATA1	ALT0	NVCC_SD2
P41	SDIO_D2	Bi-Dir	-	SD2 / 3.3V	i.MX8Mplus	SD2_DATA2	ALT0	NVCC_SD2
P42	SDIO_D3	Bi-Dir	-	SD2 / 3.3V	i.MX8Mplus	SD2_DATA3	ALT0	NVCC_SD2
P43	SPI0_CS0#	Out	-	SPI / 1.8V	i.MX8Mplus	ECSPI2_SS0	ALT0	NVCC_ECSPi
P44	SPI0_CLK	Out	-	SPI / 1.8V	i.MX8Mplus	ECSPI2_SCLK	ALT0	NVCC_ECSPi
P45	SPI0_DIN	In	-	SPI / 1.8V	i.MX8Mplus	ECSPI2_MISO	ALT0	NVCC_ECSPi
P46	SPI0_DO	Out	-	SPI / 1.8V	i.MX8Mplus	ECSPI2_MOSI	ALT0	NVCC_ECSPi
P47	GND	-	-	-	-	-	-	-
P48	SATA_TX+	-	-	-	N.C.	N.C.	-	-
P49	SATA_TX-	-	-	-	N.C.	N.C.	-	-
P50	GND	-	-	-	-	-	-	-
P51	SATA_RX+	-	-	-	N.C.	N.C.	-	-
P52	SATA_RX-	-	-	-	N.C.	N.C.	-	-
P53	GND	-	-	-	-	-	-	-
P54	ESPI_CS0# / SPI1_CS0#	Out	-	SPI / 1.8V	i.MX8Mplus	ECSPI1_SS0	ALT0	NVCC_ECSPi

	SMARC Signal Name	Module Direction	Module Termination	Type/Tolerance	Controller	Controller Pin Name	I/O Mux default	Power Rail
P55	ESPI_CS1# / SPI1_CS1#	-	-	-	N.C.	N.C.	-	-
P56	ESPI_CK / SPI1_CK	Out	-	SPI / 1.8V	i.MX8Mplus	ECSPI1_SCLK	ALT0	NVCC_ECSPi
P57	ESPI_IO_1 / SPI1_DIN	In	-	SPI / 1.8V	i.MX8Mplus	ECSPI1_MISO	ALT0	NVCC_ECSPi
P58	ESPI_IO_0 / SPI1_DO	Out	-	SPI / 1.8V	i.MX8Mplus	ECSPI1_MOSI	ALT0	NVCC_ECSPi
P59	GND	-	-	-	-	-		
P60	USB0+	Bi-Dir	-	USB	i.MX8Mplus	USB1_DP		USB1_VDD33
P61	USB0-	Bi-Dir	-	USB	i.MX8Mplus	USB1_DN		USB1_VDD33
P62	USB0_EN_OC#	In	PU-10K	GPIO / 3.3V	i.MX8Mplus	GPIO1_IO13	ALT0	NVCC_GPIO1
P63	USB0_VBUS_DET	PWR	-	USB	i.MX8Mplus	USB1_VBUS	-	USB1_VDD33
P64	USB0_OTG_ID	In	-	USB	i.MX8Mplus	USB1_ID	-	USB1_VDD33
P65	USB1+	Bi-Dir	-	USB	USB Hub (FL5500-2F0)	DS4_DP	-	AVDD33
P66	USB1-	Bi-Dir	-	USB	USB Hub (FL5500-2F0)	DS4_DM	-	AVDD33
P67	USB1_EN_OC#	In	-	GPIO / 3.3V	USB Hub (FL5500-2F0)	DS4_OVRCURR	-	AVDD33
P68	GND	-	-	-	-	-		
P69	USB2+	Bi-Dir	-	PHY	USB Hub (FL5500-2F0)	DS0_DP	-	AVDD33
P70	USB2-	Bi-Dir	-	PHY	USB Hub (FL5500-2F0)	DS0_DM	-	AVDD33
P71	USB2_EN_OC#	In	-	GPIO / 3.3V	USB Hub (FL5500-2F0)	DS0_OVRCURR	-	AVDD33
P72	RSVD	-	-	-	N.C.	N.C.		
P73	RSVD	-	-	-	N.C.	N.C.		
P74	USB3_EN_OC#	In	-	GPIO / 3.3V	USB Hub (FL5500-2F0)	DS1_OVRCURR	-	AVDD33
P75	PCIE_A_RST#	Out	-	GPIO / 3.3V	i.MX8Mplus	SAI1_TXC	ALT5	NVCC_SAI1
P76	USB4_EN_OC#	In	-	GPIO / 3.3V	USB Hub (FL5500-2F0)	DS3_OVRCURR	-	AVDD33
P77	PCIE_B_CKREQ#	-	-	-	N.C.	N.C.	-	-
P78	PCIE_A_CKREQ#	-	-	-	N.C.	N.C.	-	-
P79	GND	-	-	-	-	-	-	-
P80	PCIE_C_REFCK+	Out	-	-	N.C.	N.C.	-	-
P81	PCIE_C_REFCK-	Out	-	-	N.C.	N.C.	-	-
P82	GND	-	-	-	-	-	-	-
P83	PCIE_A_REFCK+	Out	Serial-0.1uF	PCIe	PI7C9X2G304EV	DIF3	-	VDDDIG1p8

	SMARC Signal Name	Module Direction	Module Termination	Type/Tolerance	Controller	Controller Pin Name	I/O Mux default	Power Rail
P84	PCIE_A_REFCK-	Out	Serial-0.1uF	PCle	PI7C9X2G304EV	DIF3\	-	VDDDIG1p8
P85	GND	-	-		-	-	-	-
P86	PCIE_A_RX+	In	Serial-0.1uF	PCle	i.MX8Mplus	PCIE2_RXN_P	-	PCIE2_VPH
P87	PCIE_A_RX-	In	Serial-0.1uF	PCle	i.MX8Mplus	PCIE2_RXN_N	-	PCIE2_VPH
P88	GND	-	-	-	-	-	-	-
P89	PCIE_A_TX+	Out	Serial-0.1uF	PCle	i.MX8Mplus	PCIE2_TXN_P	-	PCIE2_VPH
P90	PCIE_A_TX-	Out	Serial-0.1uF	PCle	i.MX8Mplus	PCIE2_TXN_N	-	PCIE2_VPH
P91	GND	-	-	-	-	-		
P92	HDMI_D2+ / DP1_LANE0+	Out	-	HDMI	i.MX8Mplus	HDMI_TX_P_LN_2	-	HDMI_AVDDIO
P93	HDMI_D2- / DP1_LANE0-	Out	-	HDMI	i.MX8Mplus	HDMI_TX_N_LN_2	-	HDMI_AVDDIO
P94	GND	-	-	-	-	-	-	-
P95	HDMI_D1+ / DP1_LANE1+	Out	-	HDMI	i.MX8Mplus	HDMI_TX_P_LN_1		HDMI_AVDDIO
P96	HDMI_D1- / DP1_LANE1-	Out	-	HDMI	i.MX8Mplus	HDMI_TX_N_LN_1		HDMI_AVDDIO
P97	GND	-	-	-	-	-	-	-
P98	HDMI_D0+ / DP1_LANE2+	Out	-	HDMI	i.MX8Mplus	HDMI_TX_P_LN_0	-	HDMI_AVDDIO
P99	HDMI_D0- / DP1_LANE2-	Out	-	HDMI	i.MX8Mplus	HDMI_TX_N_LN_0	-	HDMI_AVDDIO
P100	GND	-	-	-	-	-	-	-
P101	HDMI_CK+ / DP1_LANE3+	Out	-	HDMI	i.MX8Mplus	HDMI_TX_P_LN_3	-	HDMI_AVDDIO
P102	HDMI_CK- / DP1_LANE3-	Out	-	HDMI	i.MX8Mplus	HDMI_TX_N_LN_3	-	HDMI_AVDDIO
P103	GND	-	-	-	-	-	-	-
P104	HDMI_HPD / DP1_HPD	In		HDMI	i.MX8Mplus	HDMI_HPD	-	HDMI_AVDDIO
P105	HDMI_CTRL_CK / DP1_AUX+	Out	PU-2.2K / PD-100K	HDMI	i.MX8Mplus	HDMI_DDC_SCL(H) HDMI_AUXP(L)	-	HDMI_AVDDIO
P106	HDMI_CTRL_DAT / DP1_AUX-	Bi-Dir	PU-2.2K / PD-100K	HDMI	i.MX8Mplus	HDMI_DDC_SDA(H) HDMI_AUXN(L)	-	HDMI_AVDDIO
P107	DP1_AUX_SEL	Out	PD-1M	HDMI	TS5A23159RSER	-	-	-
P108	GPIO0 / CAM0_PWR#	Out	PU-470K	GPIO / 1.8V	i.MX8M	GPIO1_IO03	ALT0	NVCC_GPIO1
P109	GPIO1 / CAM1_PWR#	Out	PU-470K	GPIO / 1.8V	i.MX8M	GPIO1_IO05	ALT0	NVCC_GPIO1
P110	GPIO2 / CAM0_RST#	Out	PU-470K	GPIO / 1.8V	i.MX8M	GPIO1_IO06	ALT0	NVCC_GPIO1

	SMARC Signal Name	Module Direction	Module Termination	Type/Tolerance	Controller	Controller Pin Name	I/O Mux default	Power Rail
P111	GPIO3 / CAM1_RST#	Out	PU-470K	GPIO / 1.8V	i.MX8M	GPIO1_IO07	ALT0	NVCC_GPIO1
P112	GPIO4 / HDA_RST#	Out	PU-470K	GPIO / 1.8V	SX1509	P0_4	-	VDD_1V8
P113	GPIO5 / PWM_OUT	Out	PU-470K	GPIO / 1.8V	SX1509	P0_5	-	VDD_1V8
P114	GPIO6 / TACHIN	In	PU-470K	GPIO / 1.8V	SX1509	P0_6	-	VDD_1V8
P115	GPIO7	In	PU-470K	GPIO / 1.8V	SX1509	P0_7	-	VDD_1V8
P116	GPIO8	In	PU-470K	GPIO / 1.8V	SX1509	P1_0	-	VDD_1V8
P117	GPIO9	In	PU-470K	GPIO / 1.8V	SX1509	P1_1	-	VDD_1V8
P118	GPIO10	In	PU-470K	GPIO / 1.8V	SX1509	P1_2	-	VDD_1V8
P119	GPIO11	In	PU-470K	GPIO / 1.8V	SX1509	P1_3	-	VDD_1V8
P120	GND	-	-	-	-	-	-	-
P121	I2C_PM_CK	Out	PU-2k2	I2C1	i.MX8Mplus	I2C1_SCL	ALT0	NVCC_I2C
P122	I2C_PM_DAT	Bi-Dir	PU-2k2	I2C1	i.MX8Mplus	I2C1_SDA	ALT0	NVCC_I2C
P123	BOOT_SEL0#	In	PU-4k7	GPIO / 1.8V	BMC	PB0	-	+1V8SMC
P124	BOOT_SEL1#	In	PU-4k7	GPIO / 1.8V	BMC	PB1	-	+1V8SMC
P125	BOOT_SEL2#	In	PU-4k7	GPIO / 1.8V	BMC	PB2	-	+1V8SMC
P126	RESET_OUT#	Out	-	GPIO / 1.8V	BMC	PB15	-	+1V8SMC
P127	RESET_IN#	In	PU-4K7	GPIO / 1.8V	BMC	PB14	-	+1V8SMC
P128	POWER_BTN#	In	PU-4K7	GPIO / 1.8V	BMC	PB4	-	+1V8SMC
P129	SER0_TX	Out	-	UART / 1.8V	i.MX8Mplus	UART2_TXD	ALT5	NVCC_UART
P130	SER0_RX	In	-	UART / 1.8V	i.MX8Mplus	UART2_RXD	ALT5	NVCC_UART
P131	SER0_RTS#	In	-	UART / 1.8V	i.MX8Mplus	SD1_DATA4	ALT1	NVCC_SD1
P132	SER0_CTS#	Out	-	UART / 1.8V	i.MX8Mplus	SD1_DATA5	ALT1	NVCC_SD1
P133	GND	-	-	-	-	-	-	-
P134	SER1_TX	Out	-	UART / 1.8V	i.MX8Mplus	NAND_CE0_B	ALT1	NVCC_NAND
P135	SER1_RX	In	-	UART / 1.8V	i.MX8Mplus	NAND_ALE	ALT1	NVCC_NAND
P136	SER2_TX	Out	-	UART / 1.8V	i.MX8Mplus	UART4_TXD	ALT5	NVCC_UART
P137	SER2_RX	In	-	UART / 1.8V	i.MX8Mplus	UART4_RXD	ALT5	NVCC_UART
P138	SER2_RTS#	In	-	UART / 1.8V	i.MX8Mplus	NAND_DATA03	ALT1	NVCC_NAND
P139	SER2_CTS#	Out	-	UART / 1.8V	i.MX8Mplus	NAND_DATA02	ALT4	NVCC_NAND

	SMARC Signal Name	Module Direction	Module Termination	Type/Tolerance	Controller	Controller Pin Name	I/O Mux default	Power Rail
P140	SER3_TX	Out	-	UART / 1.8V	i.MX8Mplus	UART1_TXD	ALT5	NVCC_UART
P141	SER3_RX	In	-	UART / 1.8V	i.MX8Mplus	UART1_RXD	ALT5	NVCC_UART
P142	GND	-	-	-	-	-	-	-
P143	CAN0_TX	Out	-	CAN	i.MX8Mplus	TXCAN	-	VDD_3V3
P144	CAN0_RX	In	-	CAN	i.MX8Mplus	RXCAN	-	VDD_3V3
P145	CAN1_TX	-	-	CAN	i.MX8Mplus	TXCAN		VDD_3V3
P146	CAN1_RX	-	-	CAN	i.MX8Mplus	RXCAN		VDD_3V3
P147	VDD_IN	PWR	-	-	From Carrier board	-	-	3 ~ 5.25 V
P148	VDD_IN	PWR	-	-	From Carrier board	-	-	3 ~ 5.25 V
P149	VDD_IN	PWR	-	-	From Carrier board	-	-	3 ~ 5.25 V
P150	VDD_IN	PWR	-	-	From Carrier board	-	-	3 ~ 5.25 V
P151	VDD_IN	PWR	-	-	From Carrier board	-	-	3 ~ 5.25 V
P152	VDD_IN	PWR	-	-	From Carrier board	-	-	3 ~ 5.25 V
P153	VDD_IN	PWR	-	-	From Carrier board	-	-	3 ~ 5.25 V
P154	VDD_IN	PWR	-	-	From Carrier board	-	-	3 ~ 5.25 V
P155	VDD_IN	PWR	-	-	From Carrier board	-	-	3 ~ 5.25 V
P156	VDD_IN	PWR	-	-	From Carrier board	-	-	3 ~ 5.25 V
S1	CSI1_TX+ / I2C_CAM1_CK	In	PU-2k2	I2C5	i.MX8Mplus	I2C5_SCL	ALT0	NVCC_I2C
S2	CSI1_TX- / I2C_CAM1_DAT	In	PU-2k2	I2C5	i.MX8Mplus	I2C5_SDA	ALT0	NVCC_I2C
S3	GND	-	-	-	-	-	-	-
S4	RSVD	In	-	-	N.C.	N.C.	-	-
S5	CSI0_TX- / I2C_CAM0_CK	Out	PU-2k2	I2C3	i.MX8Mplus	I2C3_SCL	ALT0	NVCC_I2C
S6	CAM_MCK	Out	-	GPIO / 1.8V	i.MX8Mplus	GPIO1_IO15	ALT5	NVCC_GPIO1
S7	CSI0_TX+ / I2C_CAM0_DAT	Bi-Dir	PU-2k2	I2C3	i.MX8Mplus	I2C3_SDA	ALT0	NVCC_I2C
S8	CSI0_CK+	In	-	MIPI-CSI	i.MX8Mplus	MIPI_CSI1_CLK_P	-	MIPI_CSI1_VDDHA
S9	CSI0_CK-	In	-	MIPI-CSI	i.MX8Mplus	MIPI_CSI1_CLK_N	-	MIPI_CSI1_VDDHA
S10	GND	-	-	-	-	-	-	-
S11	CSI0_RX0+	In	-	MIPI-CSI	i.MX8Mplus	MIPI_CSI1_D0_P	-	MIPI_CSI1_VDDHA
S12	CSI0_RX0-	In	-	MIPI-CSI	i.MX8Mplus	MIPI_CSI1_D0_N	-	MIPI_CSI1_VDDHA

	SMARC Signal Name	Module Direction	Module Termination	Type/Tolerance	Controller	Controller Pin Name	I/O Mux default	Power Rail
S13	GND	-	-	-	-	-	-	-
S14	CSI0_RX1+	In	-	MIPI-CSI	i.MX8Mplus	MIPI_CSI1_D1_P	-	MIPI_CSI1_VDDHA
S15	CSI0_RX1-	In	-	MIPI-CSI	i.MX8Mplus	MIPI_CSI1_D1_N	-	MIPI_CSI1_VDDHA
S16	GND	-	-	-	-	-	-	-
S17	GBE1_MDI0+	Bi-Dir	-	GBE MDI	i.MX8Mplus	TD_M_D	-	-
S18	GBE1_MDI0-	Bi-Dir	-	GBE MDI	i.MX8Mplus	TD_P_D	-	-
S19	GBE1_LINK100#	Out	-	GPIO / 3.3V	i.MX8Mplus	LED_1	-	-
S20	GBE1_MDI1+	Bi-Dir	-	GBE MDI	i.MX8Mplus	LED_2	-	-
S21	GBE1_MDI1-	Bi-Dir	-	GBE MDI	i.MX8Mplus	TD_M_C	-	-
S22	GBE1_LINK1000#	Out	-	GPIO / 3.3V	i.MX8Mplus	TD_P_C	-	-
S23	GBE1_MDI2+	Bi-Dir	-	GBE MDI	i.MX8Mplus	LED_0	-	-
S24	GBE1_MDI2-	Bi-Dir	-	GBE MDI	i.MX8Mplus	TD_M_B	-	-
S25	GND	-	-	-	-	-	-	-
S26	GBE1_MDI3+	Bi-Dir	-	GBE MDI	i.MX8Mplus	MDI_PLUS[3]	-	-
S27	GBE1_MDI3-	Bi-Dir	-	GBE MDI	i.MX8Mplus	MDI_MINUS[3]	-	-
S28	GBE1_CTREF	-	-	-	N.C.	N.C.	-	-
S29	PCIE_D_TX+ / SERDES_1_TX+	-	-	-	N.C.	N.C.	-	-
S30	PCIE_D_TX- / SERDES_1_TX-	-	-	-	N.C.	N.C.	-	-
S31	GBE1_LINK_ACT#	Out	-	GPIO / 3.3V	i.MX8Mplus	LED1	-	-
S32	PCIE_D_RX+ / SERDES_1_RX+	-	-	-	N.C.	N.C.	-	-
S33	PCIE_D_RX- / SERDES_1_RX-	-	-	-	N.C.	N.C.	-	-
S34	GND	-	-	-	-	-	-	-
S35	USB4+	Bi-Dir	-	USB	USB Hub (FL5500-2F0)	DS3_DP	-	-
S36	USB4-	Bi-Dir	-	USB	USB Hub (FL5500-2F0)	DS3_DM	-	-
S37	USB3_VBUS_DET	-	-	-	N.C.	N.C.	-	-
S38	AUDIO_MCK	Out	-	SAI / 1.8V	i.MX8Mplus	SAI2_MCLK	ALT0	NVCC_SAI2
S39	I2S0_LRCK	Bi-Dir	-	SAI / 1.8V	i.MX8Mplus	SAI2_TXFS	ALT0	NVCC_SAI2
S40	I2S0_SDOOUT	Out	-	SAI / 1.8V	i.MX8Mplus	SAI2_TXD0	ALT0	NVCC_SAI2
S41	I2S0_SDIN	In	-	SAI / 1.8V	i.MX8Mplus	SAI2_RXD0	ALT0	NVCC_SAI2

	SMARC Signal Name	Module Direction	Module Termination	Type/Tolerance	Controller	Controller Pin Name	I/O Mux default	Power Rail
S42	I2S0_CK	Bi-Dir	-	SAI / 1.8V	i.MX8Mplus	SAI2_TXC	ALT0	NVCC_SAI2
S43	ESPI_ALERT0#	In	-	SAI / 1.8V	i.MX8Mplus	SAI1_RXFS	ALT5	NVCC_SAI1
S44	ESPI_ALERT1#	-	-	-	N.C.	N.C.		
S45	MDIO_CLK	-	-	-	N.C.	N.C.		
S46	MDIO_DAT	-	-	-	N.C.	N.C.		
S47	GND	-	-	-	-	-		
S48	I2C_GP_CK	Out	PU-2.2K	I2C2	i.MX8Mplus	I2C2_SCL	ALT0	NVCC_I2C
S49	I2C_GP_DAT	Bi-Dir	PU-2.2K	I2C2	i.MX8Mplus	I2C2_SDA	ALT0	NVCC_I2C
S50	HDA_SYNC / I2S2_LRCK	-	-	-	N.C.	N.C.	-	-
S51	HDA_SDO / I2S2_SDOUT	-	-	-	N.C.	N.C.	-	-
S52	HDA_SDI / I2S2_SDIN	-	-	-	N.C.	N.C.	-	-
S53	HDA_CK / I2S2_CK	-	-	-	N.C.	N.C.	-	-
S54	SATA_ACT#	-	-	-	N.C.	N.C.	-	-
S55	USB5_EN_OC#	In	-	GPIO / 3.3V	USB Hub (FL5500-2F0)	DS2_OVRCURR	-	AVDD33
S56	ESPI_IO_2	-	-	-	N.C.	N.C.	-	-
S57	ESPI_IO_3	-	-	-	N.C.	N.C.	-	-
S58	ESPI_RESET#	-	-	-	N.C.	N.C.	-	-
S59	USB5+	Bi-Dir	-	USB	USB Hub (FL5500-2F0)	DS2_DP	-	-
S60	USB5-	Bi-Dir	-	USB	USB Hub (FL5500-2F0)	DS2_DM	-	-
S61	GND	-	-	-	-	-	-	-
S62	USB3_SSTX+	Out	Serial-0.1uF	USB	USB Hub (FL5500-2F0)	DS1_TXP	-	-
S63	USB3_SSTX-	Out	Serial-0.1uF	USB	USB Hub (FL5500-2F0)	DS1_TXM	-	-
S64	GND	-	-	-	-	-	-	-
S65	USB3_SSRX+	In	-	USB	USB Hub (FL5500-2F0)	DS1_RXP	-	-
S66	USB3_SSRX-	In	-	USB	USB Hub (FL5500-2F0)	DS1_RXM	-	-
S67	GND	-	-	-	-	-	-	-
S68	USB3+	Bi-Dir	-	USB	USB Hub (FL5500-2F0)	DS1_DP	-	-
S69	USB3-	Bi-Dir	-	USB	USB Hub (FL5500-2F0)	DS1_DM	-	-
S70	GND	-	-	-	-	-	-	-

	SMARC Signal Name	Module Direction	Module Termination	Type/Tolerance	Controller	Controller Pin Name	I/O Mux default	Power Rail
S71	USB2_SSTX+	Out	Serial-0.1uF	USB	USB Hub (FL5500-2F0)	DS0_TXP	-	-
S72	USB2_SSTX-	Out	Serial-0.1uF	USB	USB Hub (FL5500-2F0)	DS0_TXM	-	-
S73	GND	-	-	-	-	-	-	-
S74	USB2_SSRX+	In	-	USB	USB Hub (FL5500-2F0)	DS0_RXP	-	-
S75	USB2_SSRX-	In	-	USB	USB Hub (FL5500-2F0)	DS0_RXM	-	-
S76	PCIE_B_RST#	Out	-	GPIO / 3.3V	i.MX8Mplus	NAND_ALE	ALT5	NVCC_NAND
S77	PCIE_C_RST#	-	-	-	N.C.	N.C.	-	-
S78	PCIE_C_RX+ / SERDES_2_RX+	-	-	-	N.C.	N.C.	-	-
S79	PCIE_C_RX- / SERDES_2_RX-	-	-	-	N.C.	N.C.	-	-
S80	GND	-	-	-	-	-	-	-
S81	PCIE_C_TX+ / SERDES_2_TX+	-	-	-	N.C.	N.C.	-	-
S82	PCIE_C_TX- / SERDES_2_TX-	-	-	-	N.C.	N.C.	-	-
S83	GND	-	-	-	-	-	-	-
S84	PCIE_B_REFCK+	Out	Serial-0.1uF	PCle	PI7C9X2G304EV	DIF1	-	VDDDIG1p8
S85	PCIE_B_REFCK-	Out	Serial-0.1uF	PCle	PI7C9X2G304EV	DIF1\	-	VDDDIG1p8
S86	GND	-	-	-	-	-	-	-
S87	PCIE_B_RX+	In	Serial-0.1uF	PCle	i.MX8Mplus	PCIE1_RXN_P	-	PCIE1_VPH
S88	PCIE_B_RX-	In	Serial-0.1uF	PCle	i.MX8Mplus	PCIE1_RXN_N	-	PCIE1_VPH
S89	GND	-	-	-	-	-	-	-
S90	PCIE_B_TX+	Out	Serial-0.1uF	PCle	i.MX8Mplus	PCIE1_TXN_P	-	PCIE1_VPH
S91	PCIE_B_TX-	Out	Serial-0.1uF	PCle	i.MX8Mplus	PCIE1_TXN_N	-	PCIE1_VPH
S92	GND	-	-	-	-	-	-	-
S93	DP0_LANE0+	-	-	-	N.C.	N.C.	-	-
S94	DP0_LANE0-	-	-	-	N.C.	N.C.	-	-
S95	DP0_AUX_SEL	-	-	-	N.C.	N.C.	-	-
S96	DP0_LANE1+	-	-	-	N.C.	N.C.	-	-
S97	DP0_LANE1-	-	-	-	N.C.	N.C.	-	-
S98	DP0_HPD	-	-	-	N.C.	N.C.	-	-
S99	DP0_LANE2+	-	-	-	N.C.	N.C.	-	-

	SMARC Signal Name	Module Direction	Module Termination	Type/Tolerance	Controller	Controller Pin Name	I/O Mux default	Power Rail
S100	DP0_LANE2-	-	-	-	N.C.	N.C.	-	-
S101	GND	-	-	-	-	-	-	-
S102	DP0_LANE3+	-	-	-	N.C.	N.C.	-	-
S103	DP0_LANE3-	-	-	-	N.C.	N.C.	-	-
S104	USB3_OTG_ID	-	-	-	N.C.	N.C.	-	-
S105	DP0_AUX+	-	-	-	N.C.	N.C.	-	-
S106	DP0_AUX-	-	-	-	N.C.	N.C.	-	-
S107	LCD1_BKLT_EN	Out	-	GPIO / 1.8V	i.MX8Mplus	GPIO1_IO00	-	-
S108	LVDS1_CK+ / eDP1_AUX+ / DSI1_CLK+	Out	Serial-OR	LVDS	i.MX8Mplus	B_CLKP	-	-
S109	LVDS1_CK- / eDP1_AUX- / DSI1_CLK-	Out	Serial-OR	LVDS	i.MX8Mplus	B_CLKN	-	-
S110	GND	-	-	-			-	-
S111	LVDS1_0+ / eDP1_TX0+ / DSI1_D0+	Out	Serial-OR	LVDS	i.MX8Mplus	B_Y0P	-	-
S112	LVDS1_0- / eDP1_TX0- / DSI1_D0-	Out	Serial-OR	LVDS	i.MX8Mplus	B_Y0N	-	-
S113	eDP1_HPD / DSI1_TE	-	-	-	N.C.	N.C.	-	-
S114	LVDS1_1+ / eDP1_TX1+ / DSI1_D1+	Out	Serial-OR	LVDS	i.MX8Mplus	B_Y1P	-	-
S115	LVDS1_1- / eDP1_TX1- / DSI1_D1-	Out	Serial-OR	LVDS	i.MX8Mplus	B_Y1N	-	-
S116	LCD1_VDD_EN	Out	-	GPIO/1.8V	i.MX8Mplus	GPIO1_IO05	-	-
S117	LVDS1_2+ / eDP1_TX2+ / DSI1_D2+	Out	Serial-OR	LVDS	i.MX8Mplus	B_Y2P	-	-
S118	LVDS1_2- / eDP1_TX2- / DSI1_D2-	Out	Serial-OR	LVDS	i.MX8Mplus	B_Y2N	-	-
S119	GND	-	-	-	-	-	-	-
S120	LVDS1_3+ / eDP1_TX3+ / DSI1_D3+	Out	Serial-OR	LVDS	i.MX8Mplus	B_Y3P	-	-
S121	LVDS1_3- / eDP1_TX3- / DSI1_D3-	Out	Serial-OR	LVDS	i.MX8Mplus	B_Y3N	-	-

	SMARC Signal Name	Module Direction	Module Termination	Type/Tolerance	Controller	Controller Pin Name	I/O Mux default	Power Rail
S122	LCD1_BKLT_PWM	Out	-	GPIO / 1.8V	i.MX8Mplus	GPIO1_IO01	ALT1	NVCC_GPIO1
S123	GPIO13	-	-	GPIO / 1.8V	SX1509	N.C.	-	-
S124	GND	-	-	-	-	-	-	-
S125	LVDS0_0+ / eDP0_TX0+ / DSI0_D0+	Out	Serial-OR	LVDS	i.MX8Mplus	A_Y0P	-	-
S126	LVDS0_0- / eDP0_TX0- / DSI0_D0-	Out	Serial-OR	LVDS	i.MX8Mplus	A_Y0N	-	-
S127	LCD0_BKLT_EN	Out	-	GPIO / 1.8V	i.MX8Mplus	GPIO1_IO10	-	-
S128	LVDS0_1+ / eDP0_TX1+ / DSI0_D1+	Out	Serial-OR	LVDS	i.MX8Mplus	A_Y1P	-	-
S129	LVDS0_1- / eDP0_TX1- / DSI0_D1-	Out	Serial-OR	LVDS	i.MX8Mplus	A_Y1N	-	-
S130	GND	-	-	-	-	-	-	-
S131	LVDS0_2+ / eDP0_TX2+ / DSI0_D2+	Out	Serial-OR	LVDS	i.MX8Mplus	A_Y2P	-	-
S132	LVDS0_2- / eDP0_TX2- / DSI0_D2-	Out	Serial-OR	LVDS	i.MX8Mplus	A_Y2N	-	-
S133	LCD0_VDD_EN	Out	-	GPIO/1.8V	i.MX8Mplus	GPIO1_IO13	-	-
S134	LVDS0_CK+ / eDP0_AUX+ / DSI0_CLK+	Out	Serial-OR	LVDS	i.MX8Mplus	A_CLKP	-	-
S135	LVDS0_CK- / eDP0_AUX- / DSI0_CLK-	Out	Serial-OR	LVDS	i.MX8Mplus	A_CLKN	-	-
S136	GND	-	-	-	-	-	-	-
S137	LVDS0_3+ / eDP0_TX3+ / DSI0_D3+	Out	Serial-OR	LVDS	i.MX8Mplus	A_Y3P	-	-
S138	LVDS0_3- / eDP0_TX3- / DSI0_D3-	Out	Serial-OR	LVDS	i.MX8Mplus	A_Y3N	-	-
S139	I2C_LCD_CK	Out	PU-2.2K	I2C3	i.MX8Mplus	I2C3_SCL	ALT0	NVCC_I2C
S140	I2C_LCD_DAT	Bi-Dir	PU-2.2K	I2C3	i.MX8Mplus	I2C3_SCL	ALT0	NVCC_I2C
S141	LCD0_BKLT_PWM	Out	-	GPIO / 1.8V	i.MX8Mplus	GPIO1_IO11	ALT1	NVCC_GPIO1
S142	GPIO12	In	PU-10K	GPIO / 1.8V	BMC	PC14	-	-
S143	GND	-	-	-	-	-	-	-

	SMARC Signal Name	Module Direction	Module Termination	Type/Tolerance	Controller	Controller Pin Name	I/O Mux default	Power Rail
S144	eDP0_HPD / DSI0_TE	In	PD-1M	GPIO / 1.8V	i.MX8Mplus	SAI3_RXC	ALT0	NVCC_SAI3
S145	WDT_TIME_OUT#	Out	-	GPIO / 1.8V	BMC	PD2	-	+1V8SMC
S146	PCIE_WAKE#	In	-	GPIO / 3.3V	i.MX8Mplus	SAI1_TXFS	ALT5	NVCC_SAI1
S147	VDD_RTC	PWR	-	PWR	-	-	-	-
S148	LID#	In	PU-4.7K	GPIO / 1.8V	i.MX8Mplus	SAI5_MCLK	ALT5	NVCC_SAI5
S149	SLEEP#	In	PU-4.7K	GPIO / 1.8V	i.MX8Mplus	SAI5_RXFS	ALT5	NVCC_SAI5
S150	VIN_PWR_BAD#	In	PU-10K	GPIO / 1.8V	BMC	PB7	-	+1V8SMC
S151	CHARGING#	Out	PU-68K	GPIO / 1.8V	i.MX8Mplus	SAI5_RXC	ALT5	NVCC_SAI5
S152	CHARGER_PRSENT#	Out	PU-100K	GPIO / 1.8V	i.MX8Mplus	SAI5_RXD0	ALT5	NVCC_SAI5
S153	CARRIER_STBY#	Out	-	GPIO / 1.8V	BMC	PB5	-	+1V8SMC

5. Software Support

5.1 Uboot / Yocto

Yocto source code and compiling instructions available at <https://github.com/adlink>

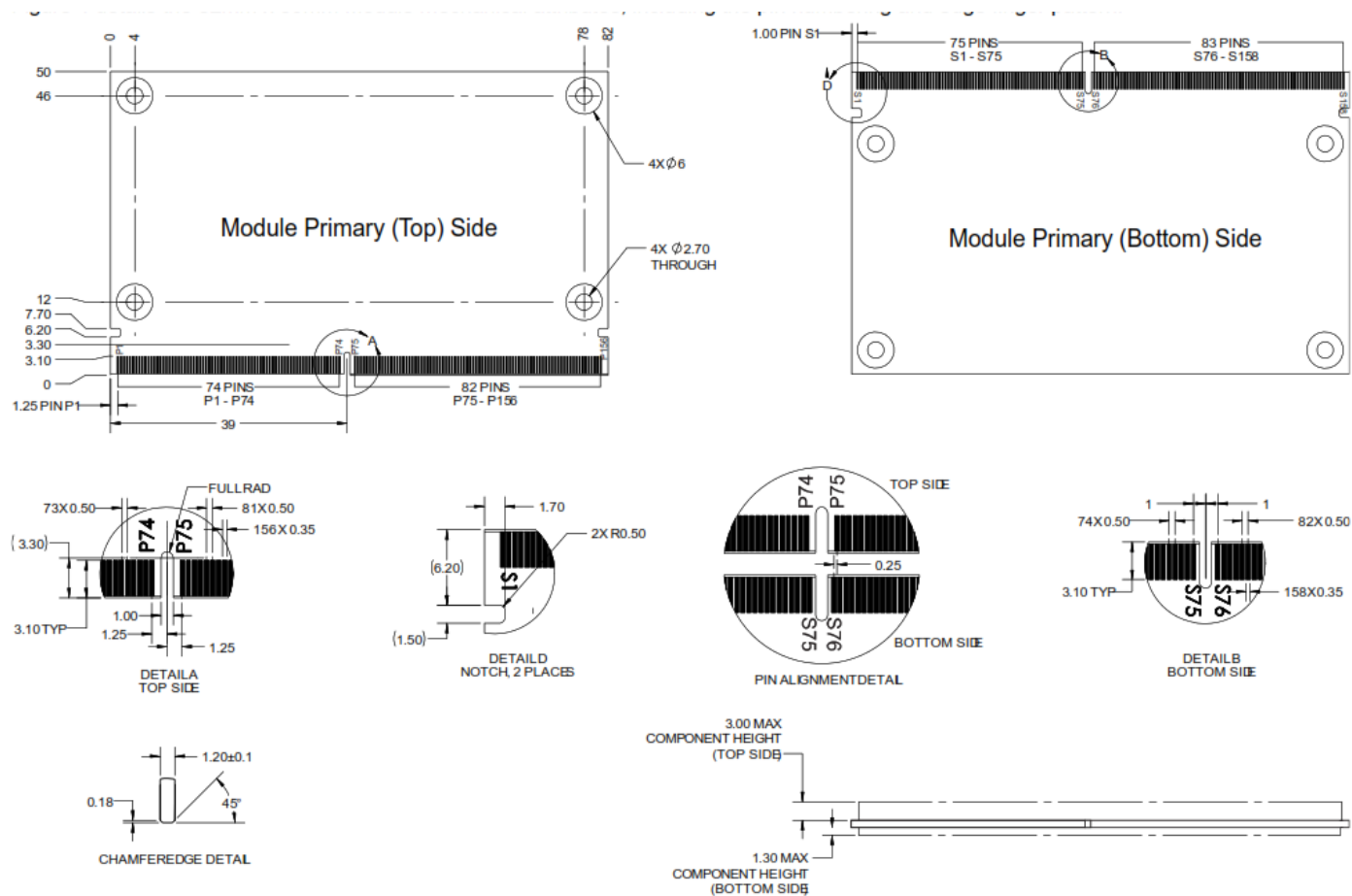
5.2 Ubuntu

Build instructions and source code available at <https://github.com/adlink>

5.3 Android

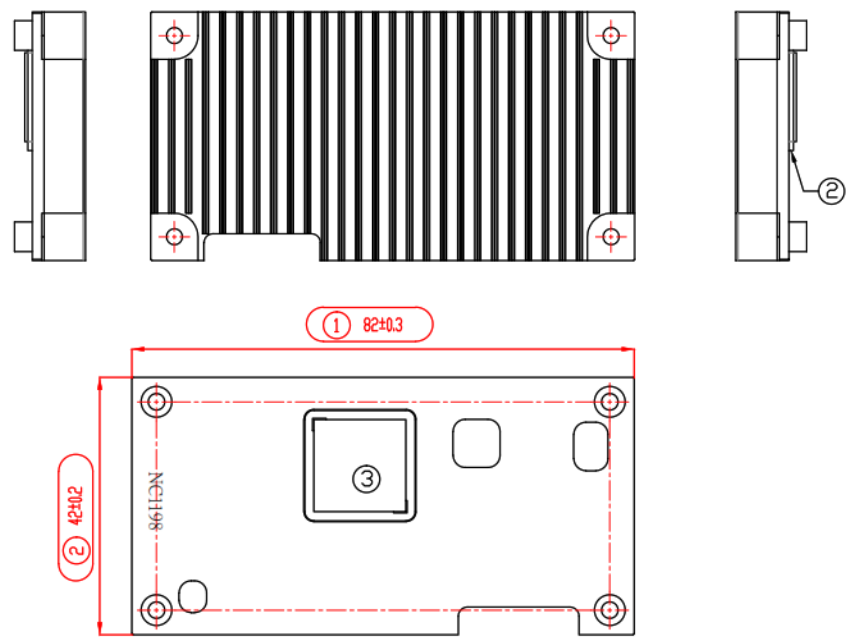
Android source code and compiling instructions available at <https://github.com/adlink>

6. Mechanical



7. Thermal Solutions

For optimal performance, LEC-IMX8M has to be cooled by a passive heatsink / heat-spreader (optionally available for ordering)



HTS-iMX8MP	Heatspreader for LEC-iMX8MP
THS-iMX8MP	Low profile heatsink for LEC-iMX8MP